

Fig. 1

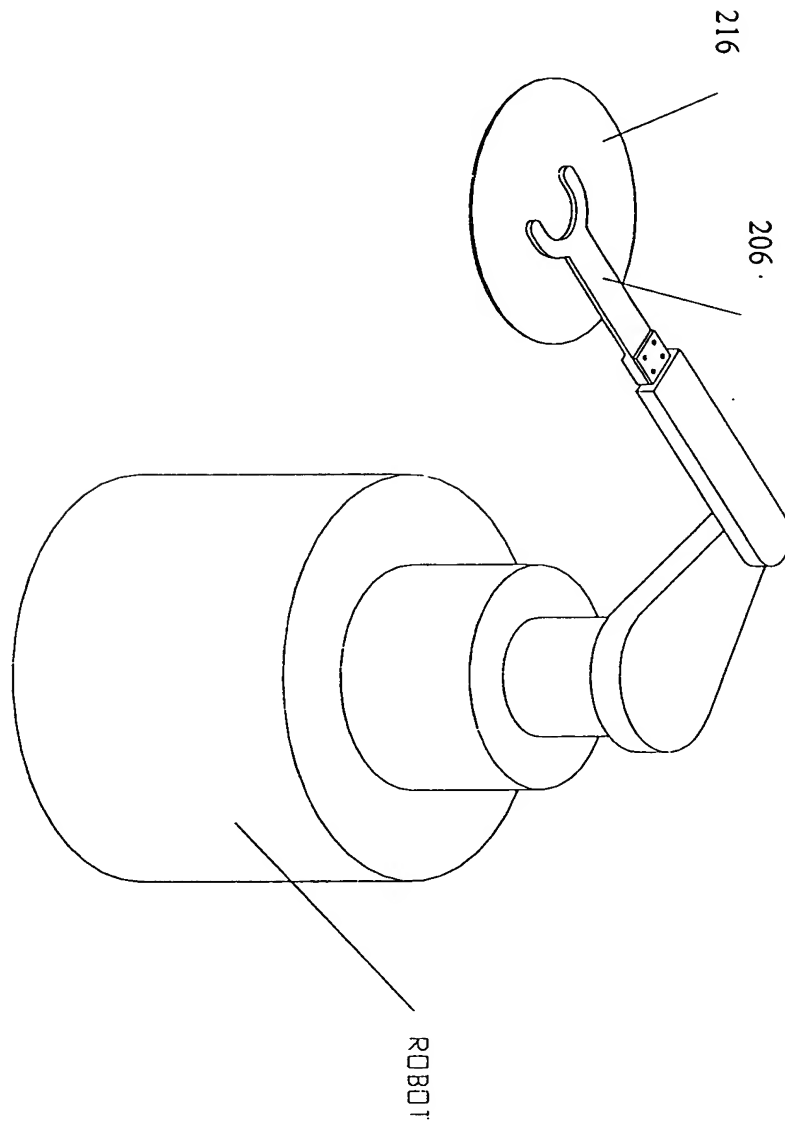


Fig. 2

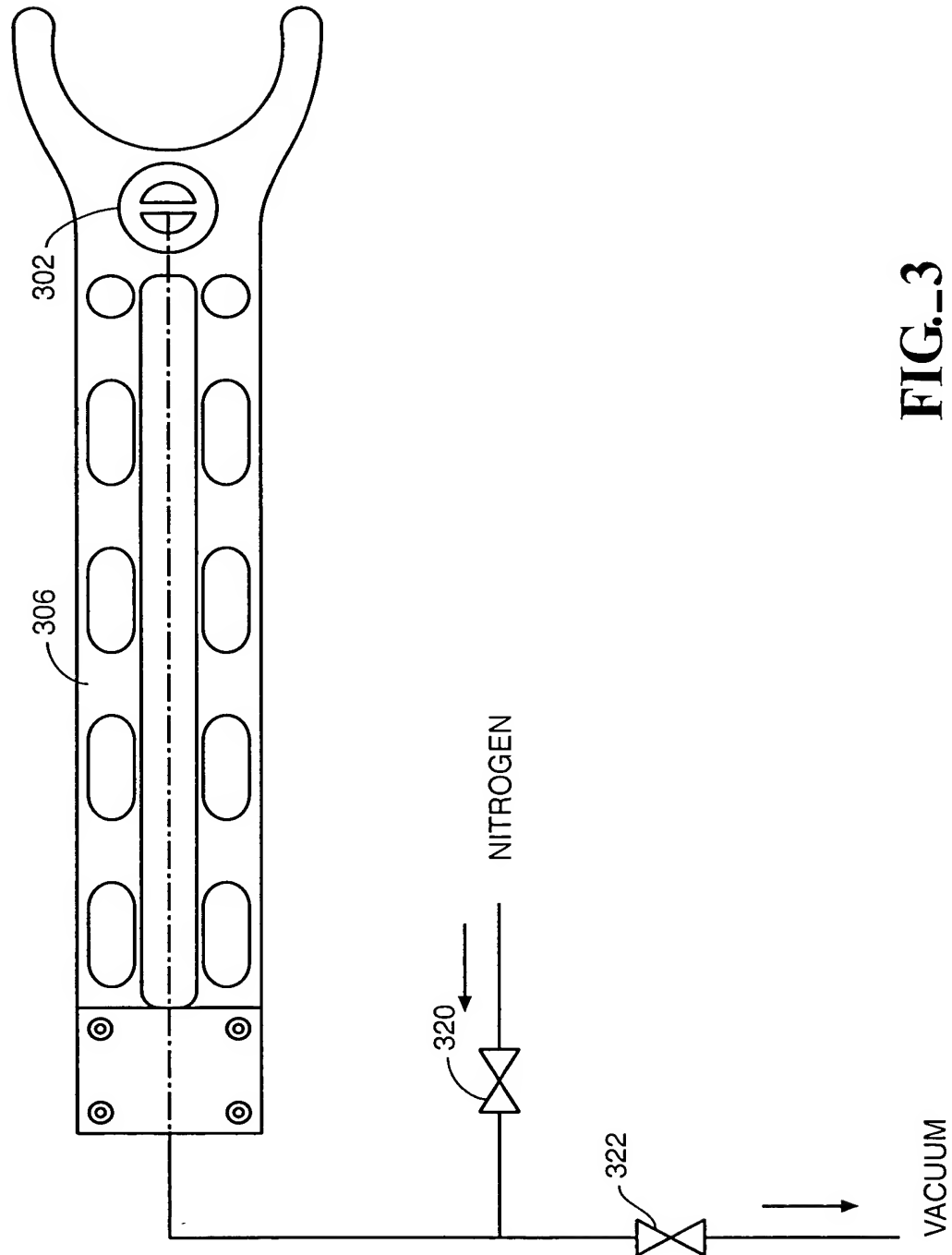


FIG. 3

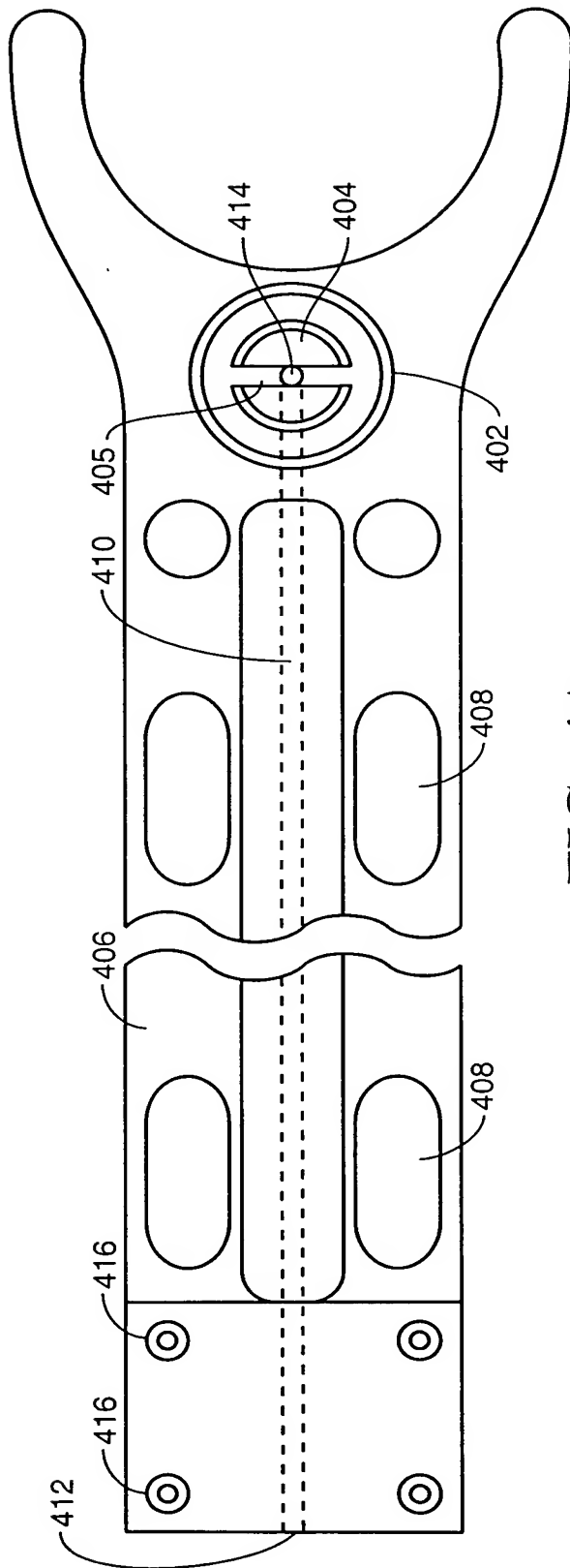


FIG. 4A

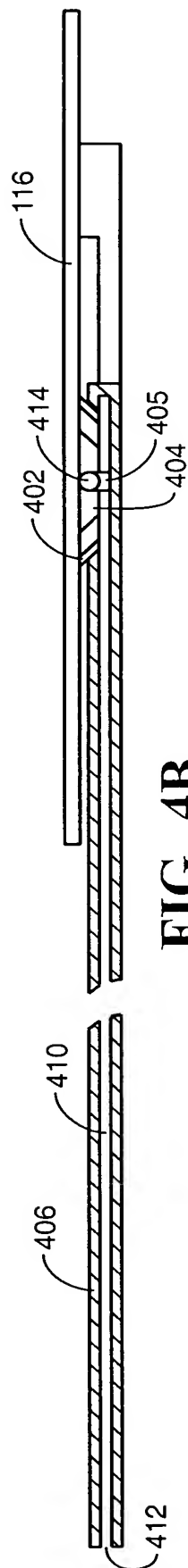


FIG. 4B

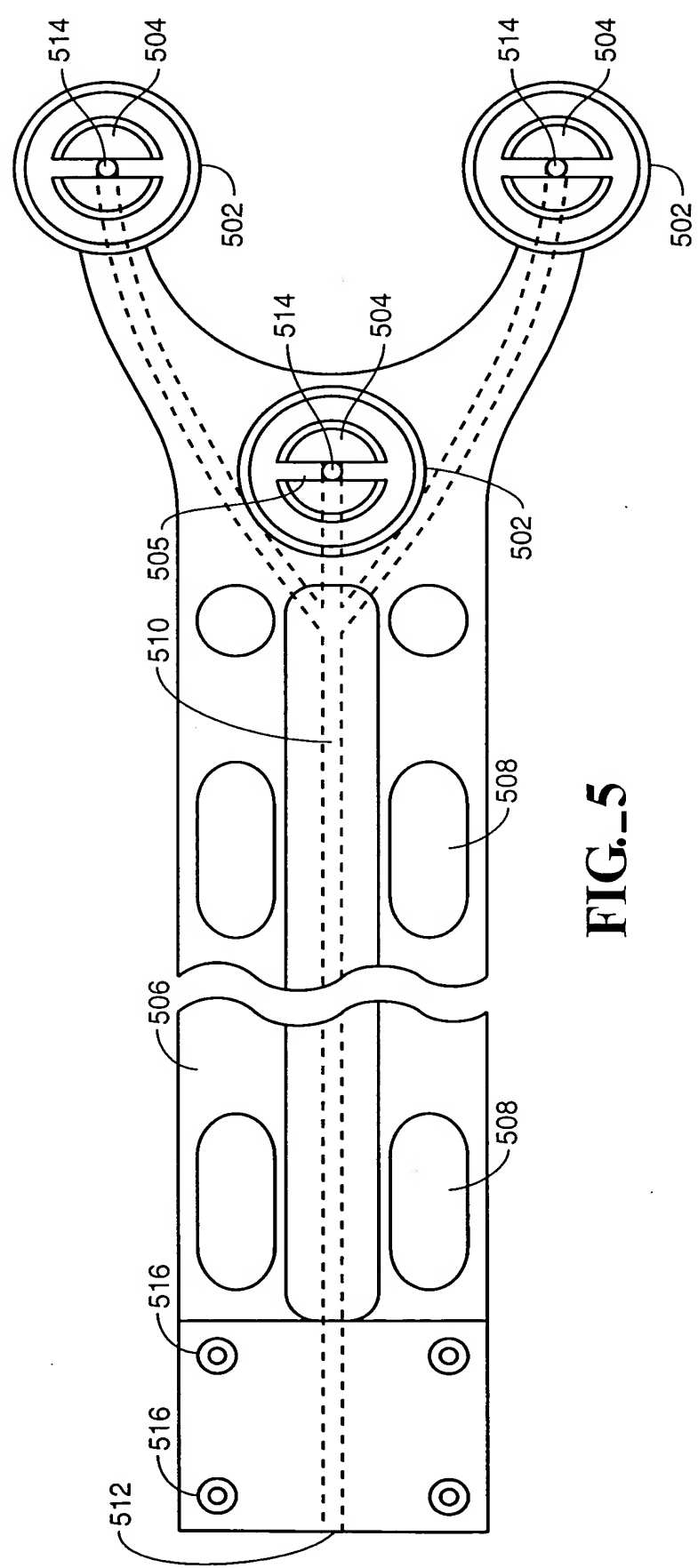


FIG. 5

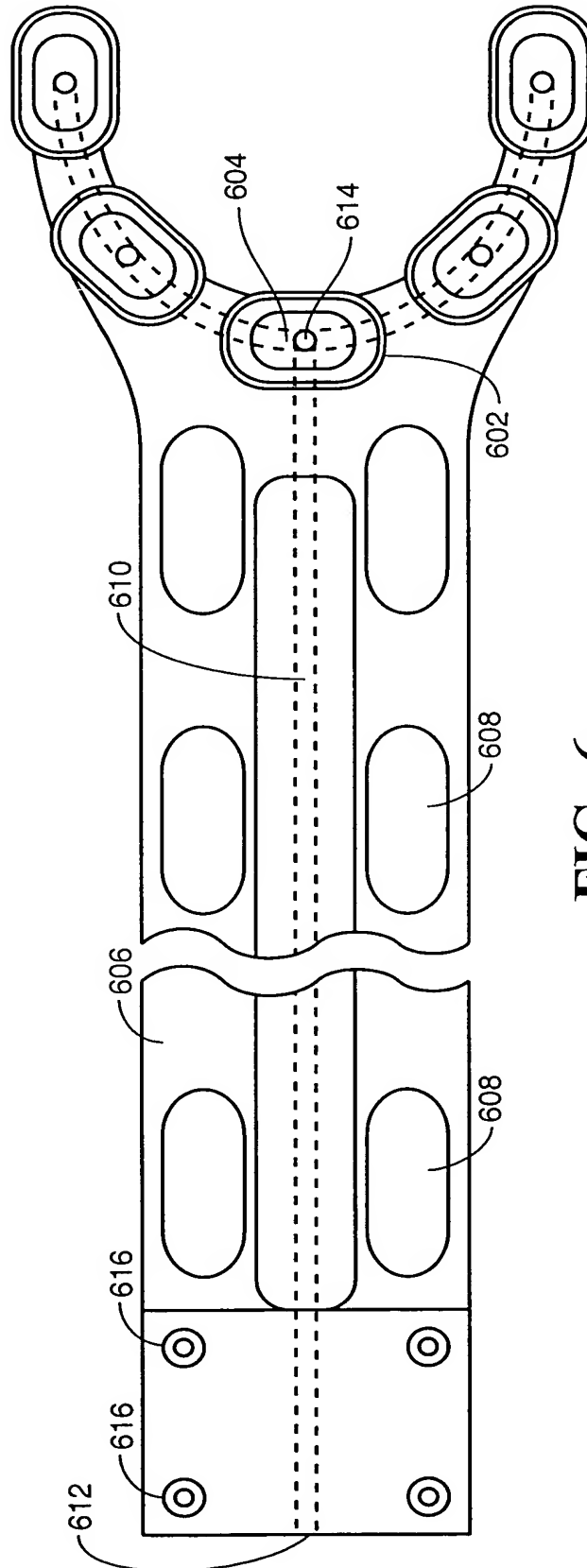
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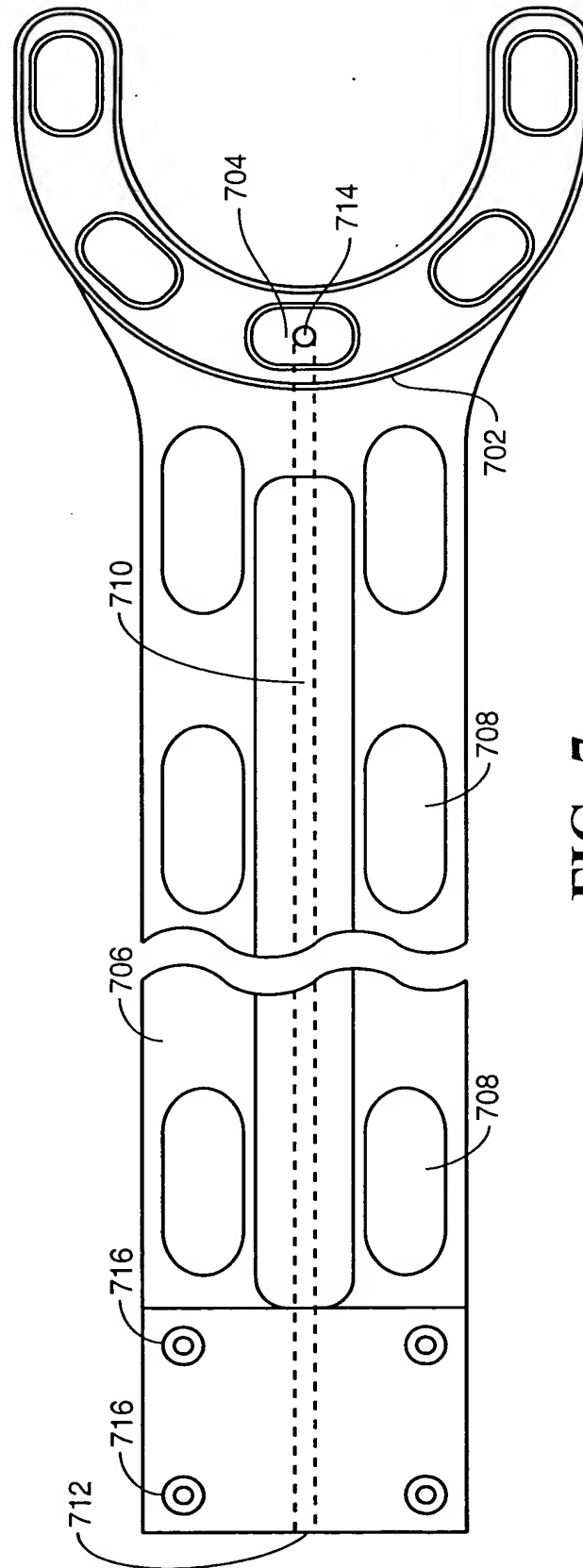


FIG. 7

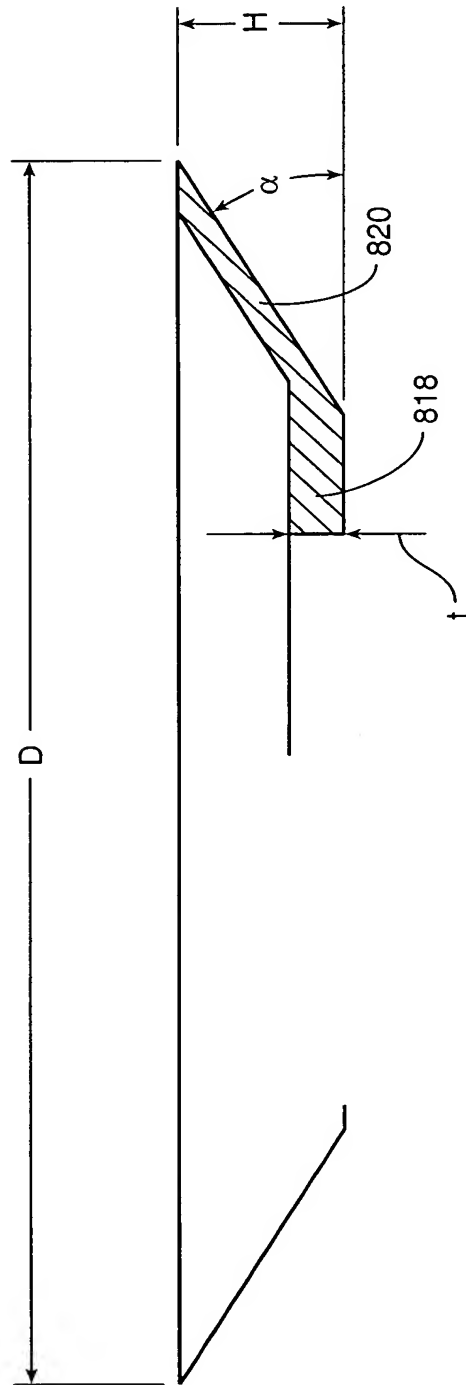
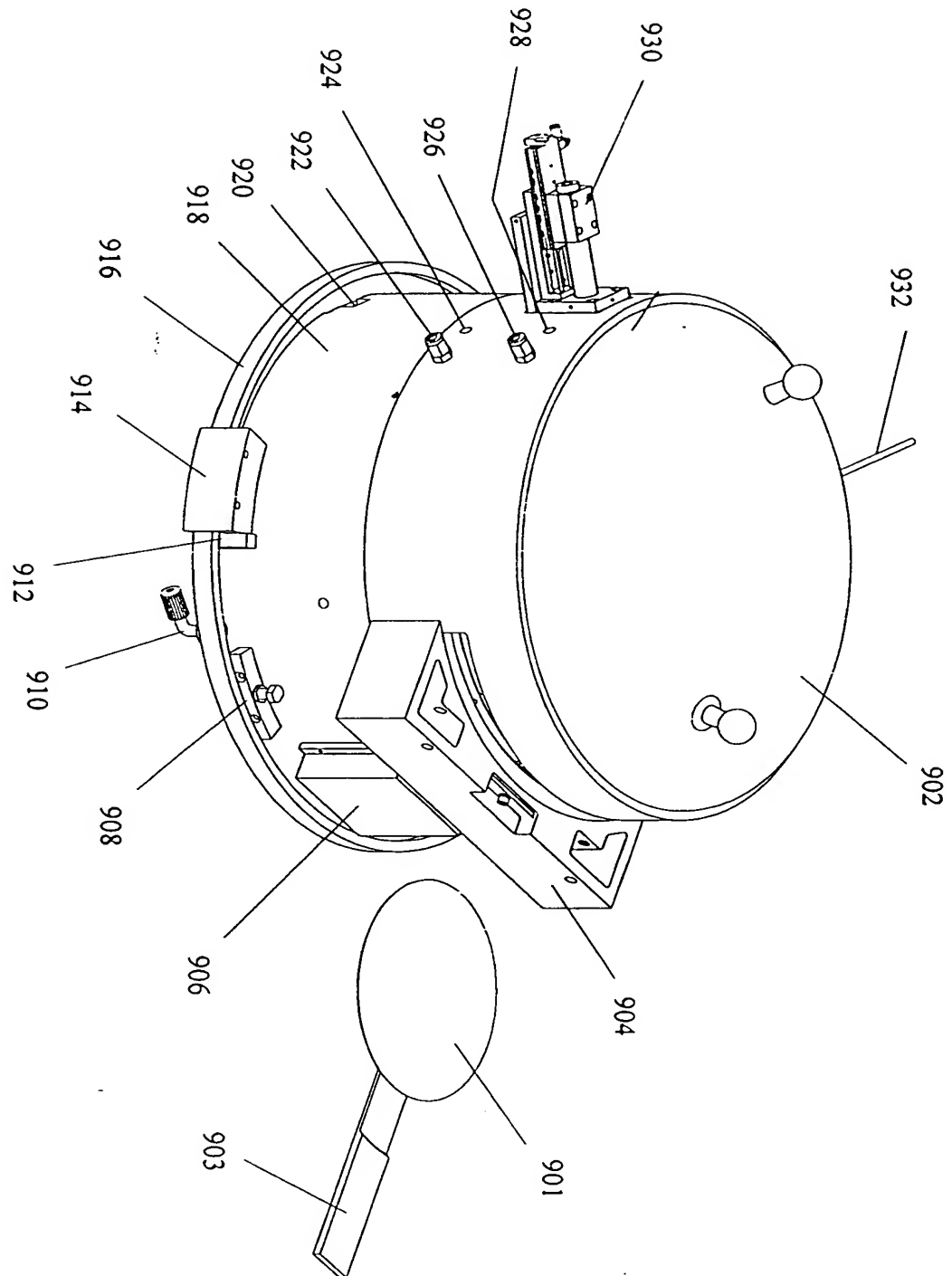


FIG.\_8



Fig. 9A



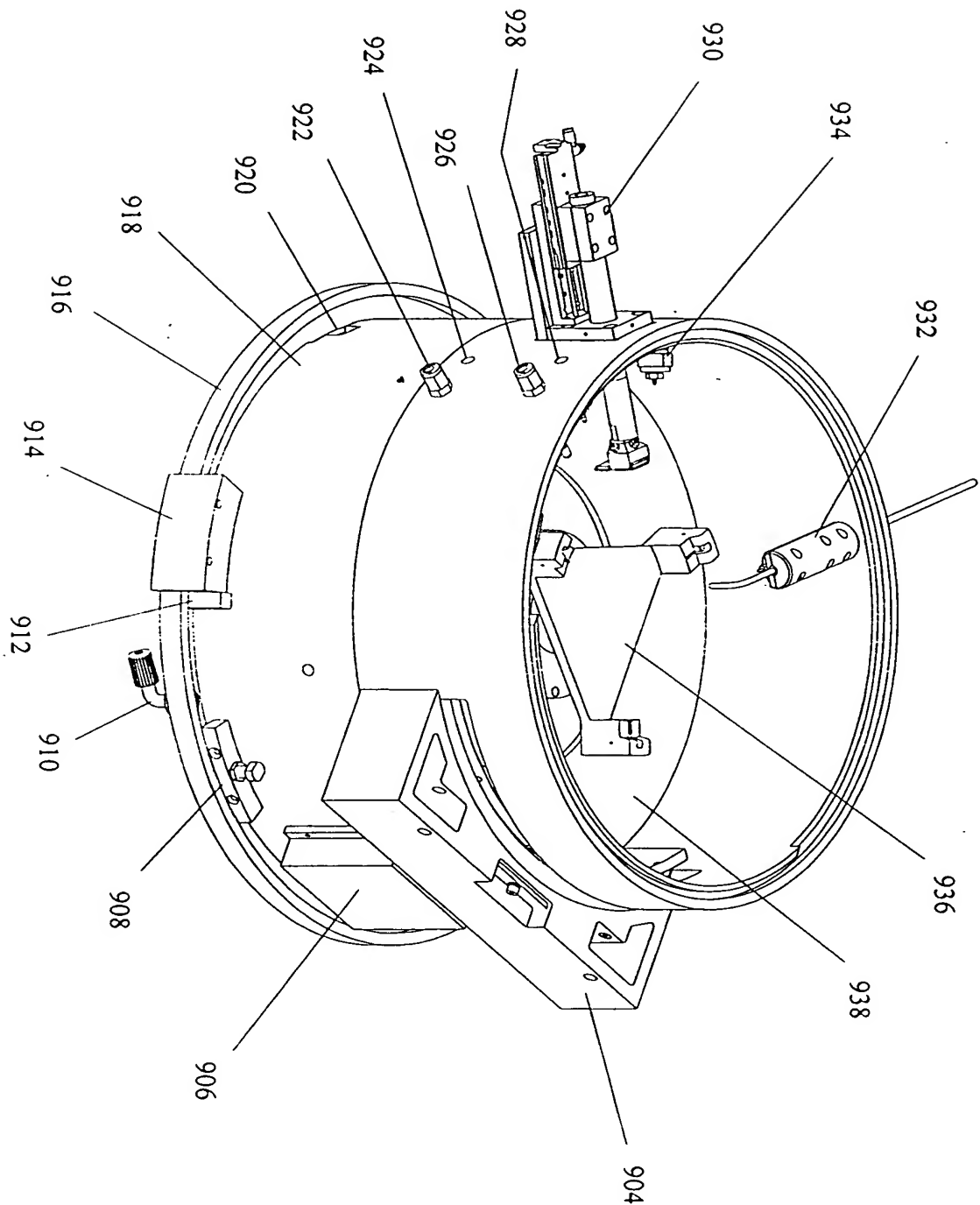
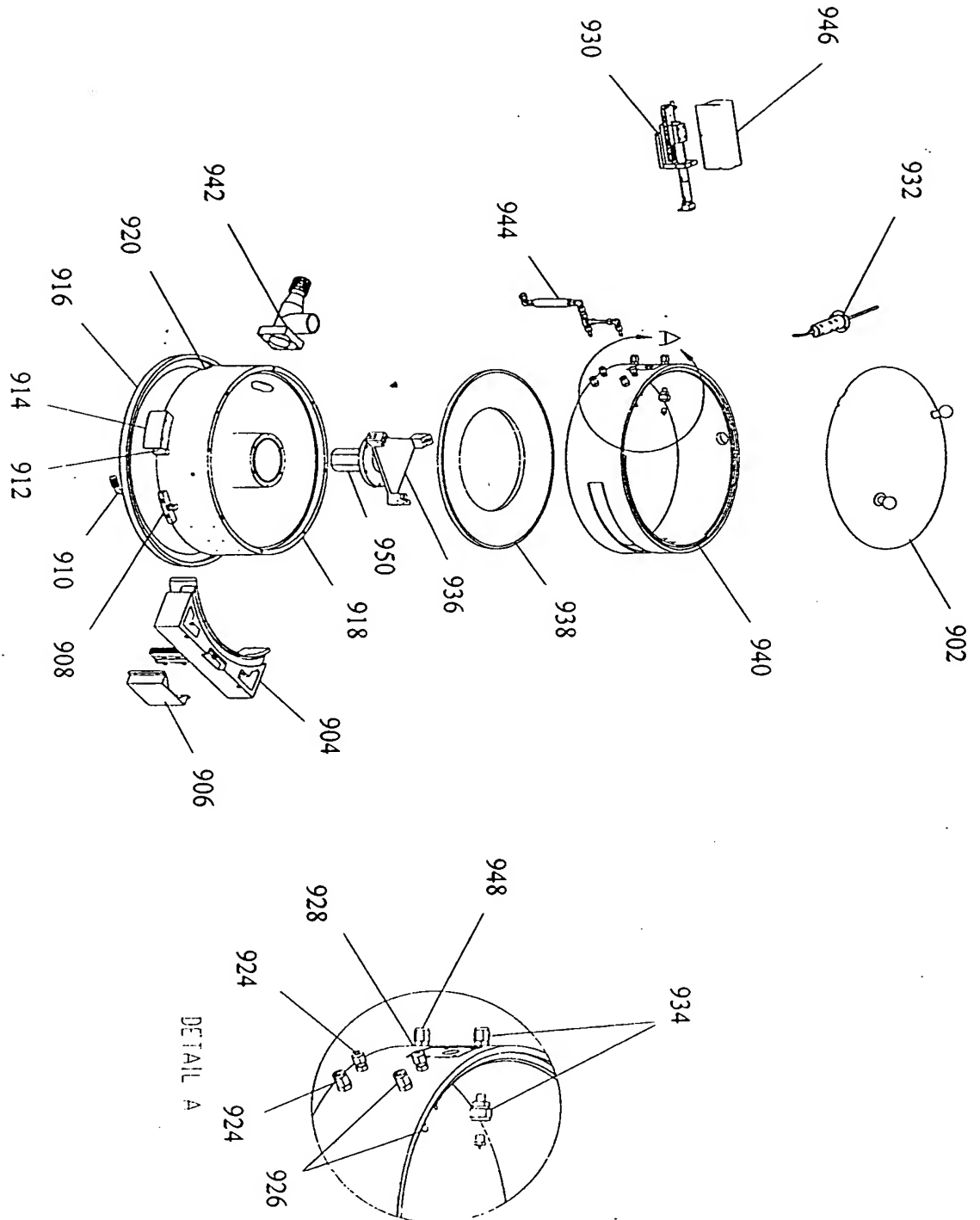
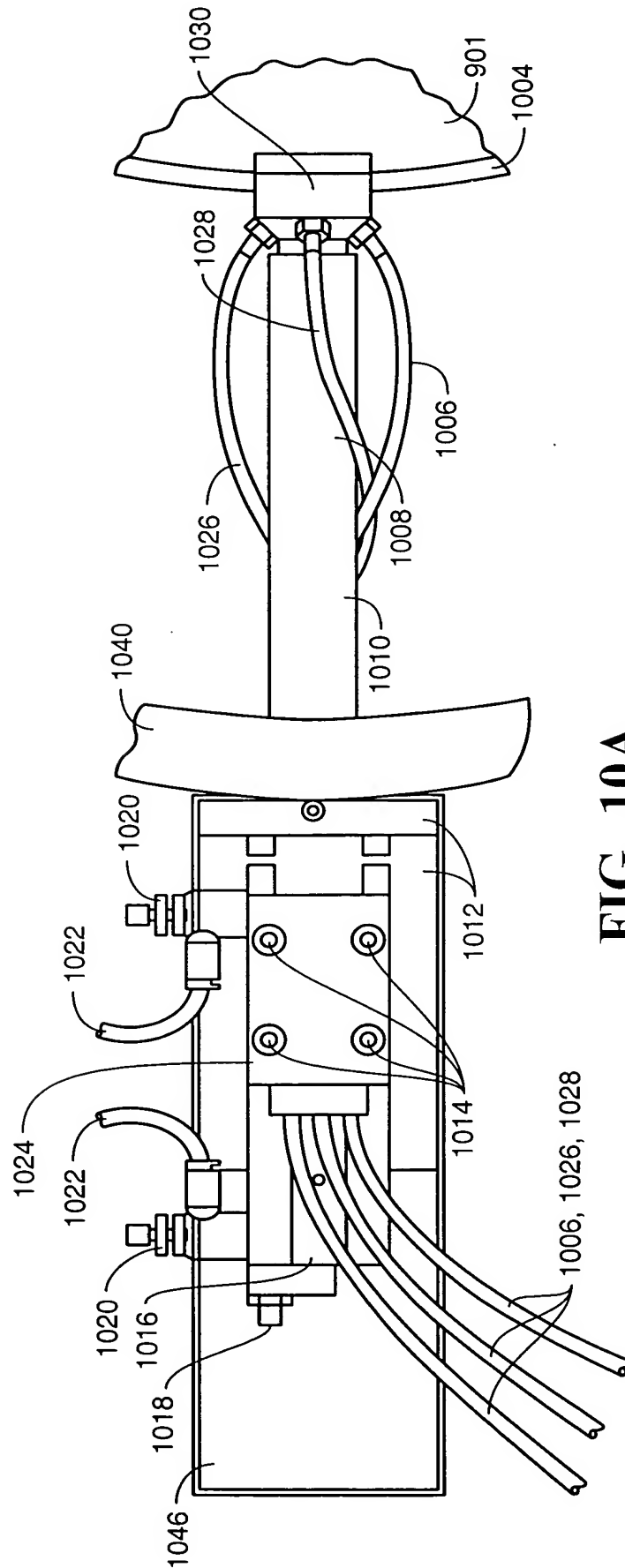


Fig. 9B

Fig. 9C





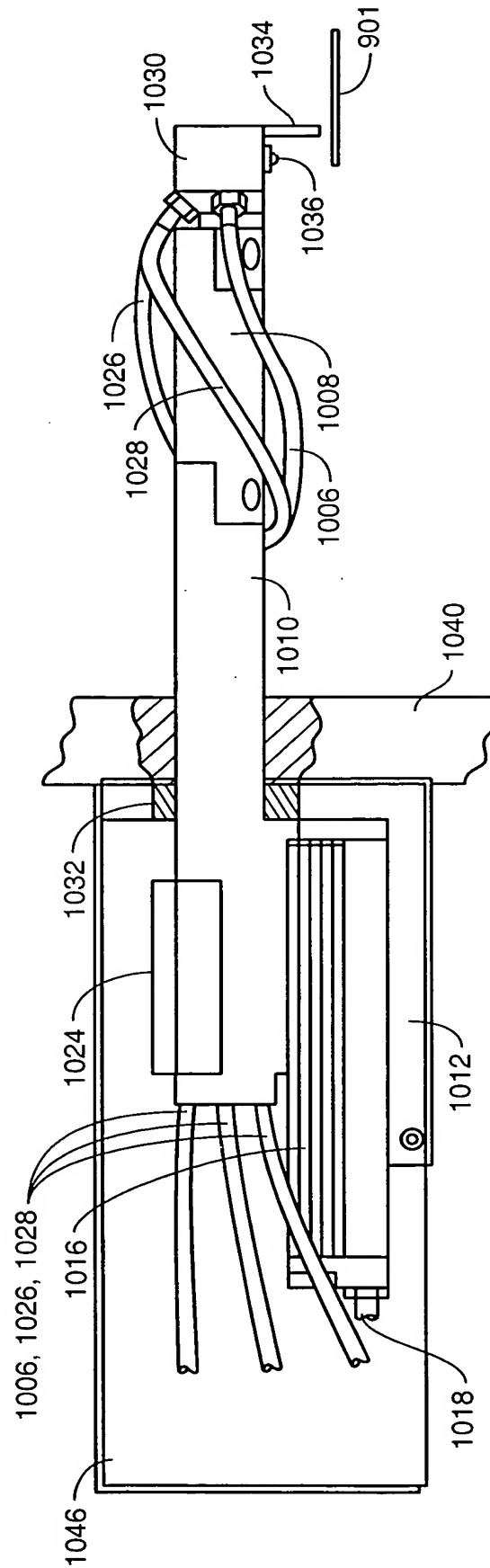
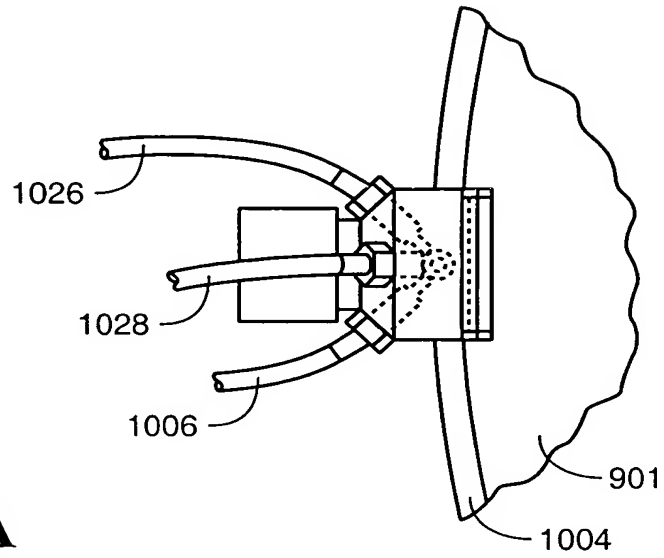
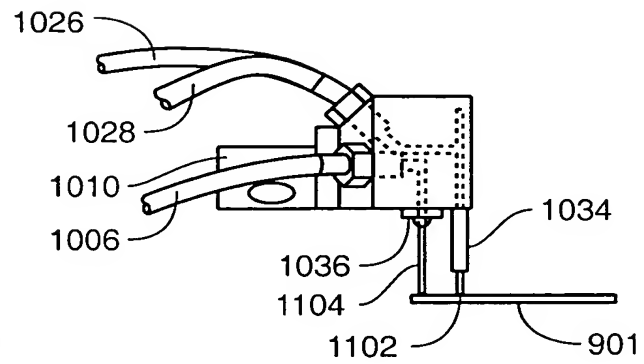
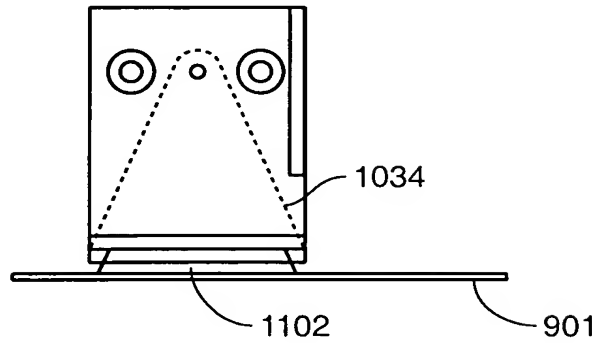
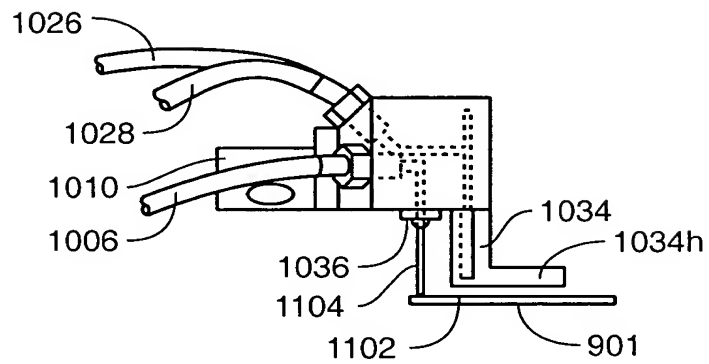
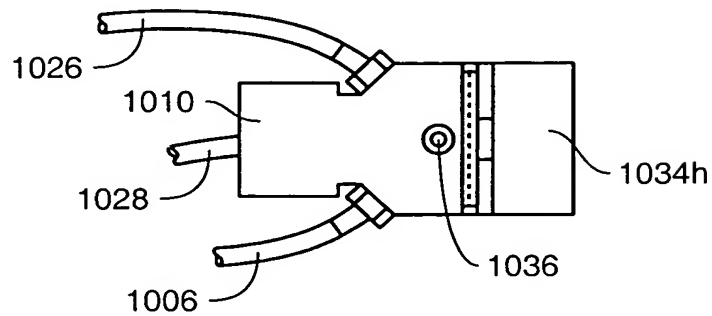
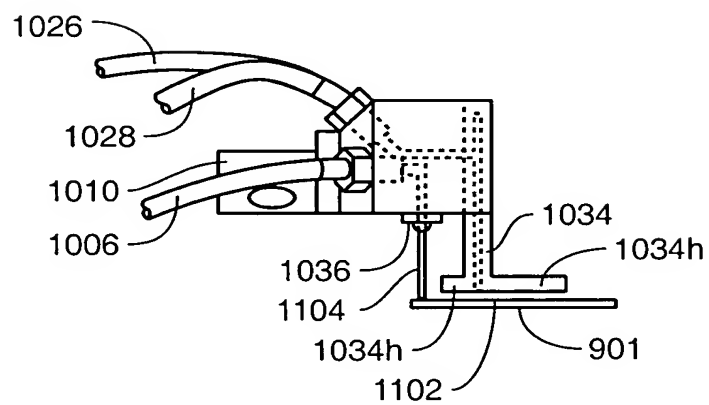


FIG. 10B

**FIG.\_11A****FIG.\_11B**

**FIG.\_11C****FIG.\_11D**

**FIG.\_11E****FIG.\_11F**



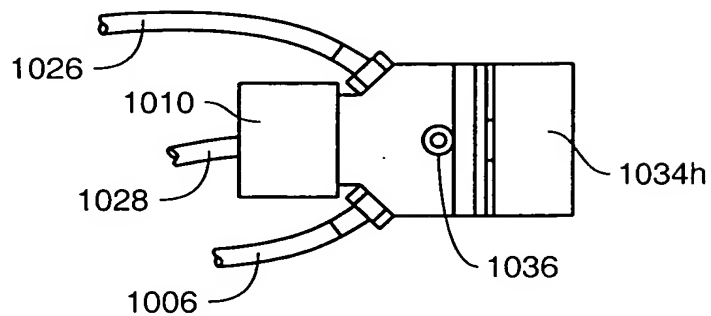


FIG. 11G

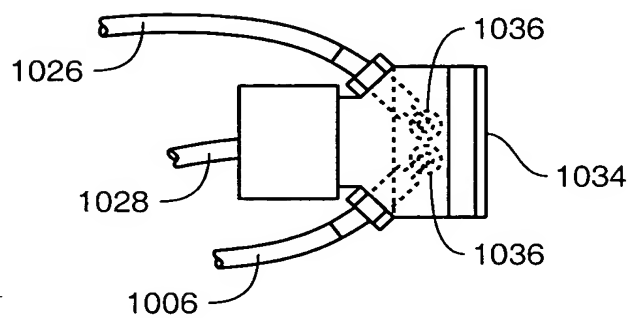


FIG. 11H

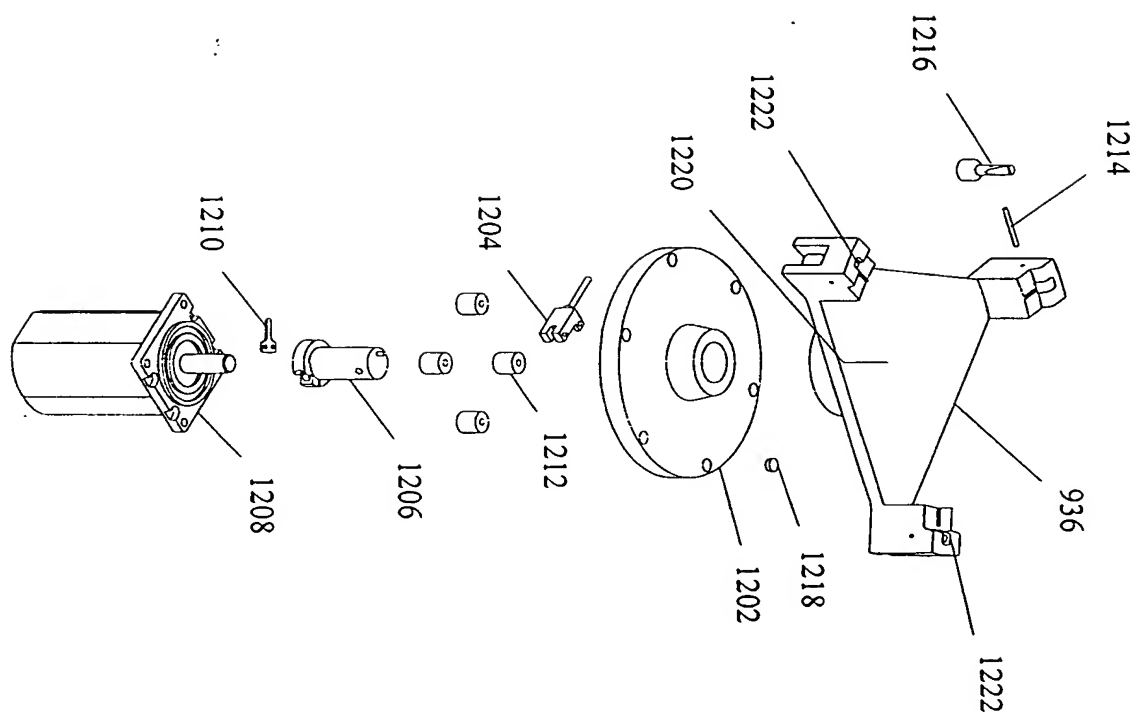
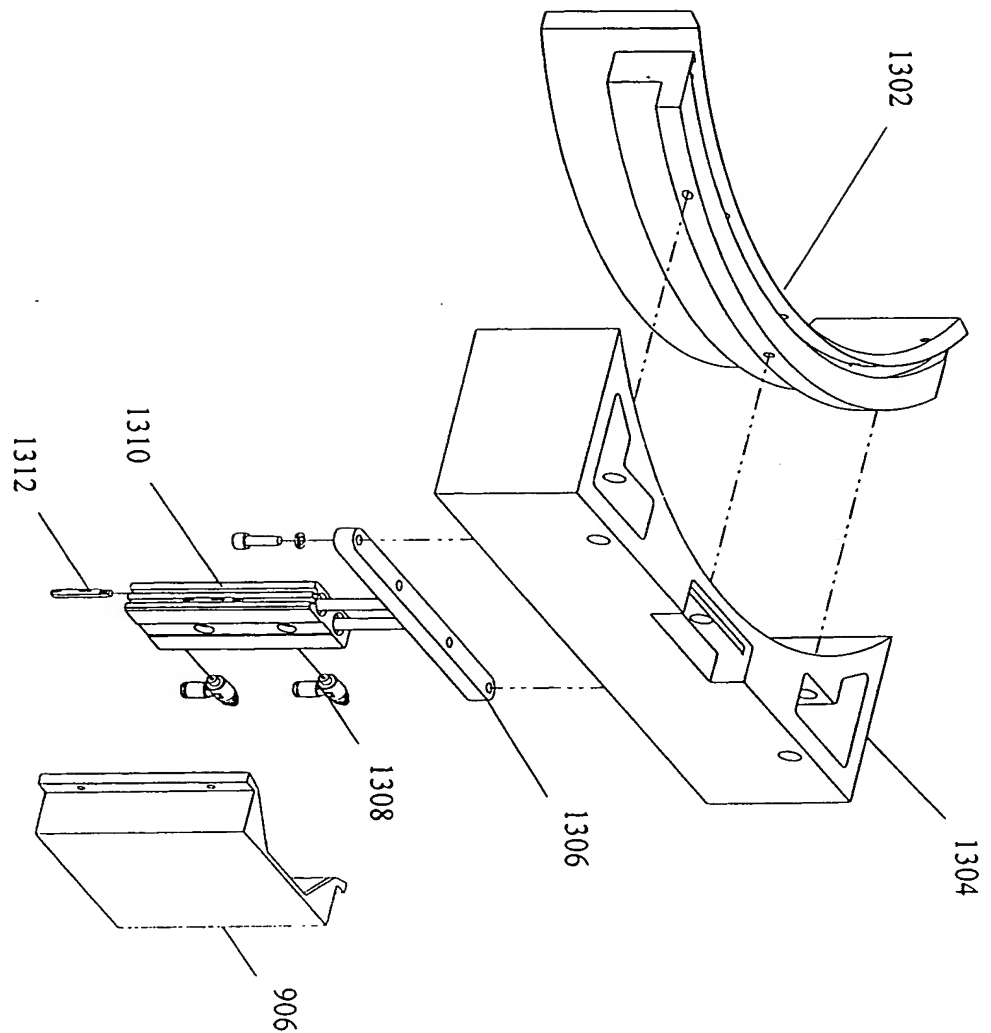


Fig. 12

Fig. 13



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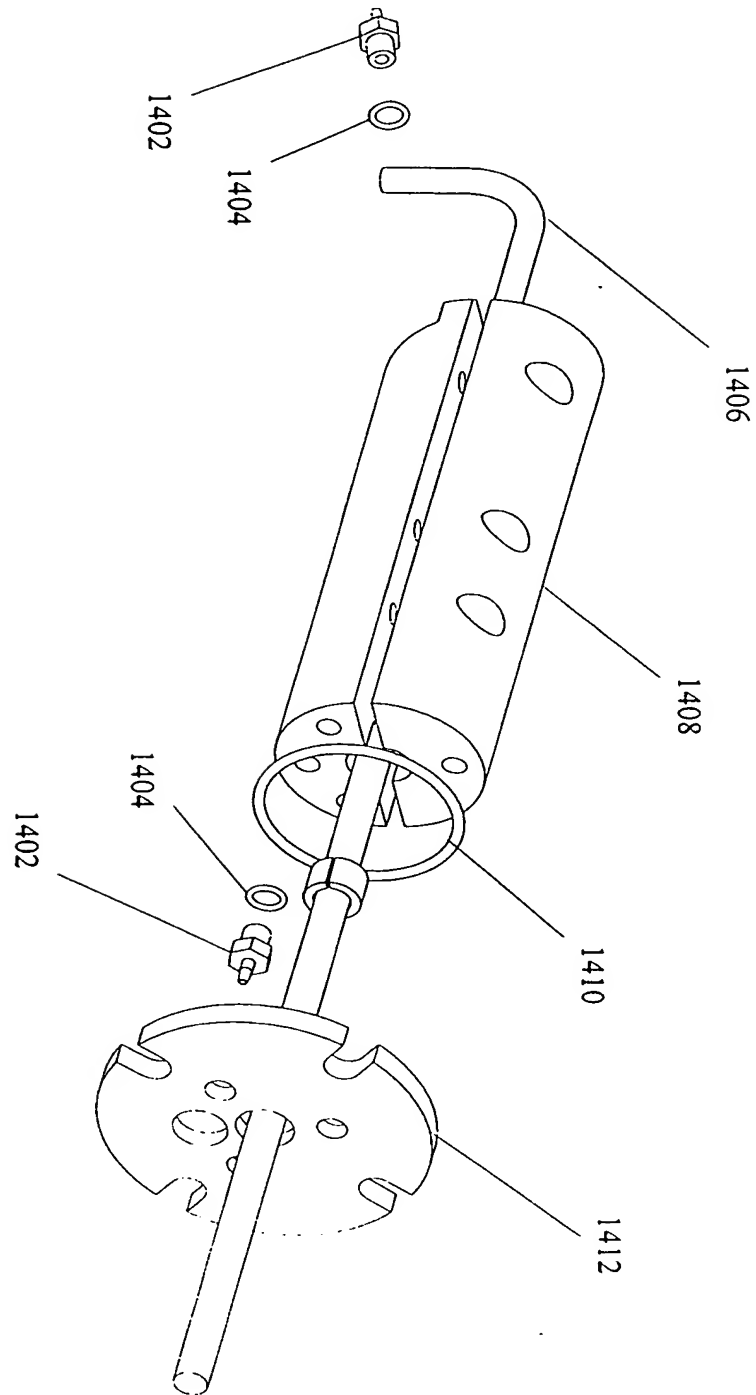
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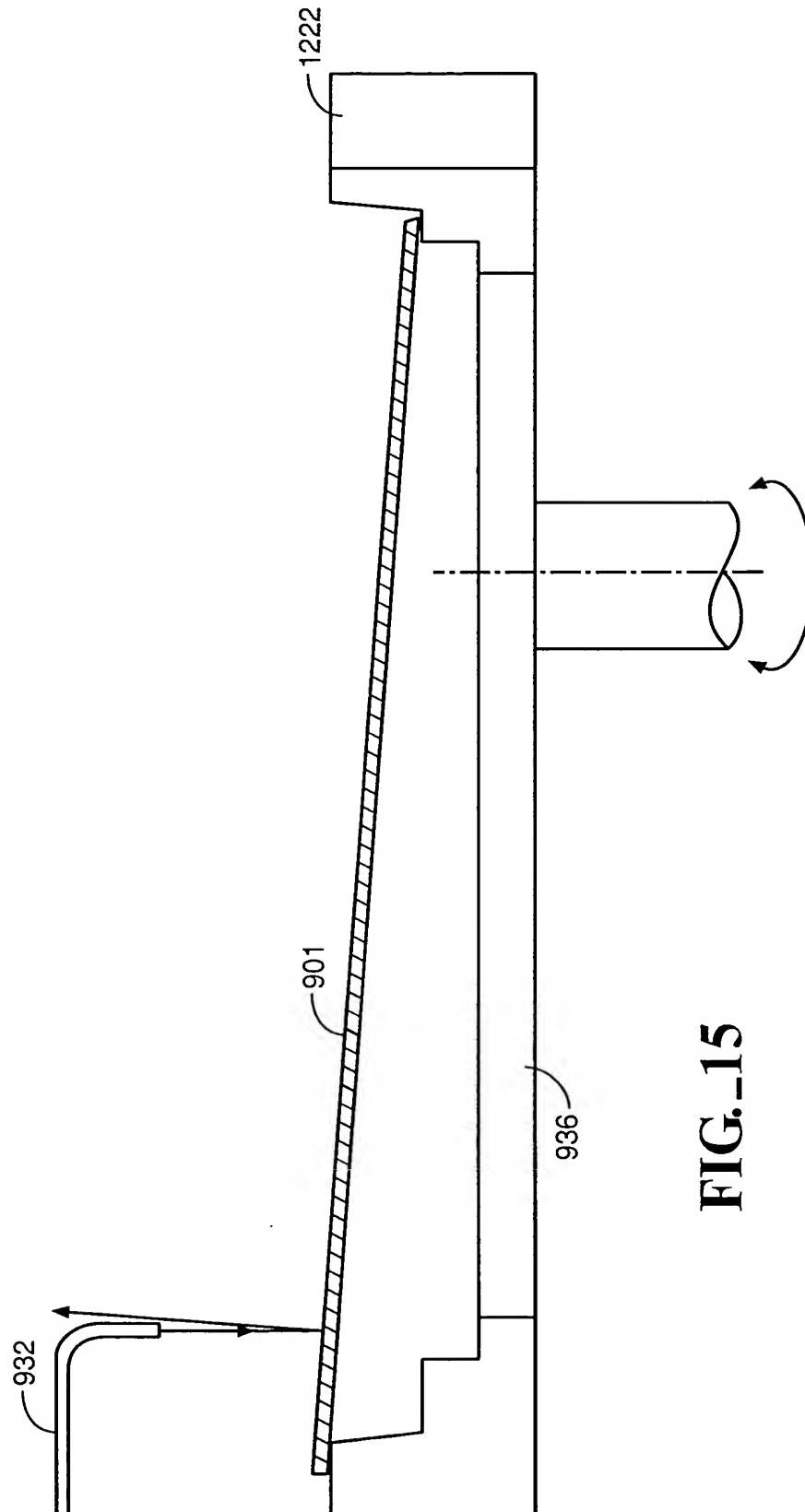
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Fig. 14





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Fig. 16A

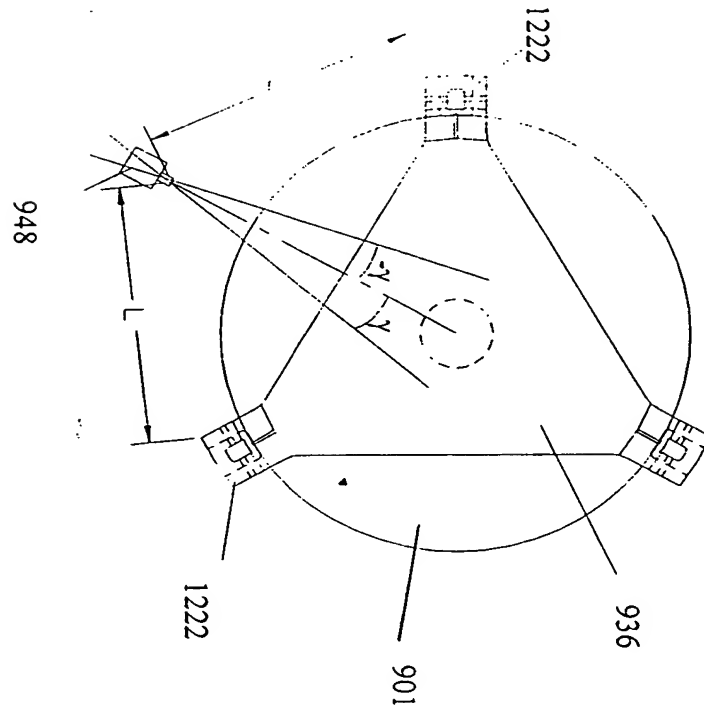


Fig. 16B

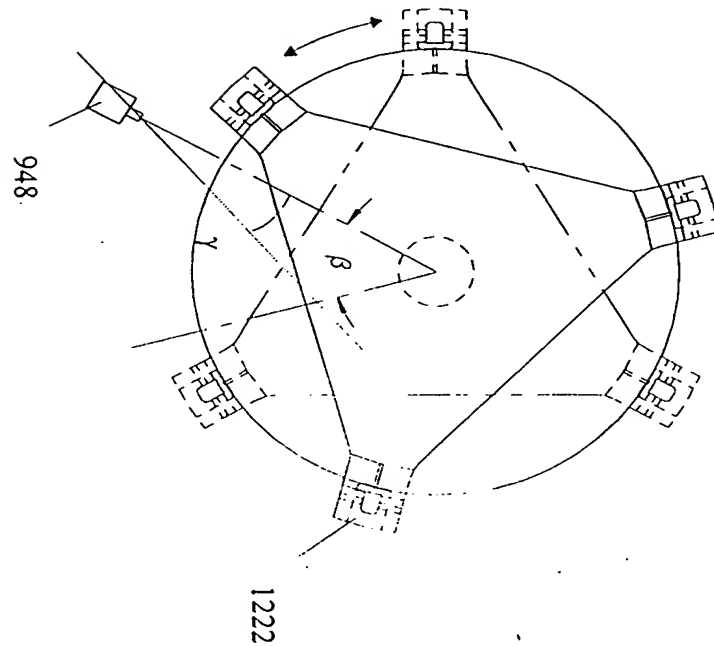


Fig. 16C

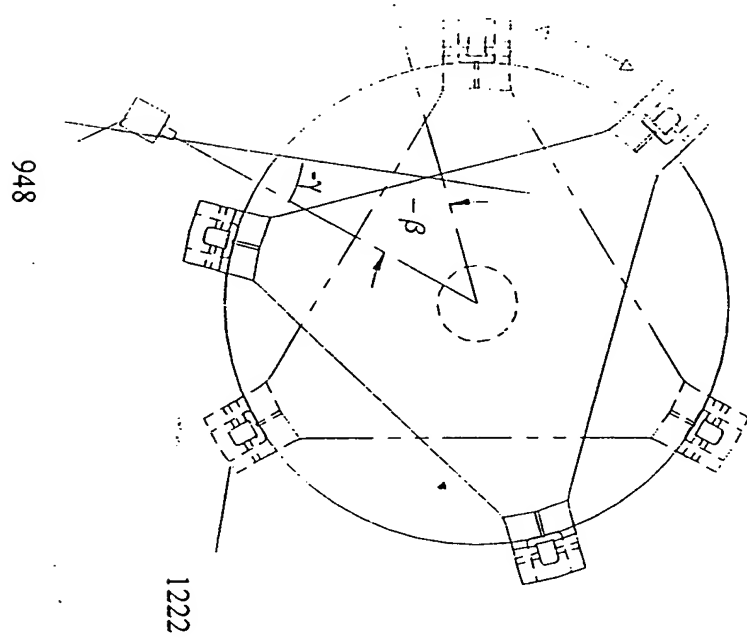
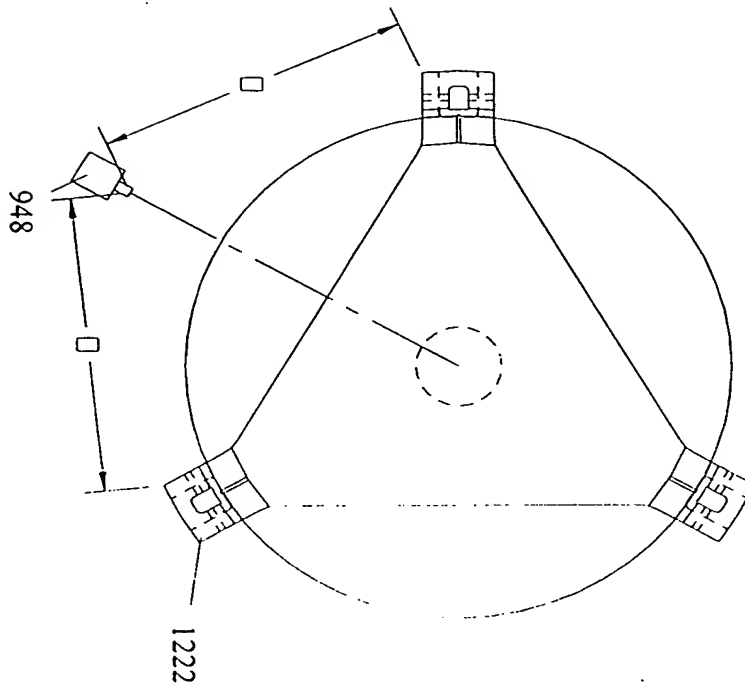


Fig. 17A



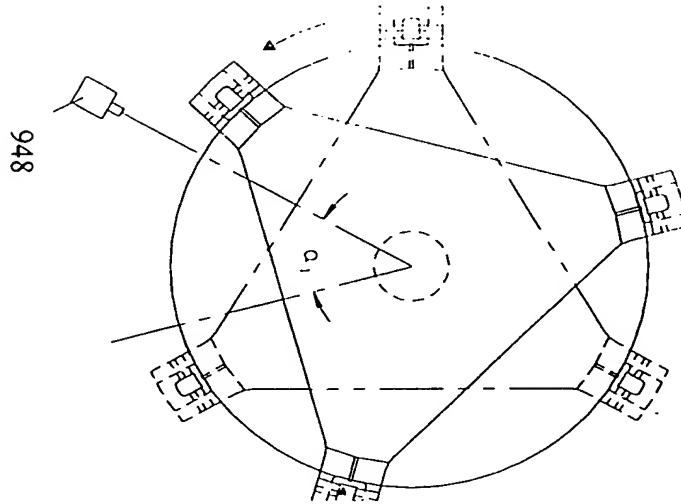


Fig. 17B

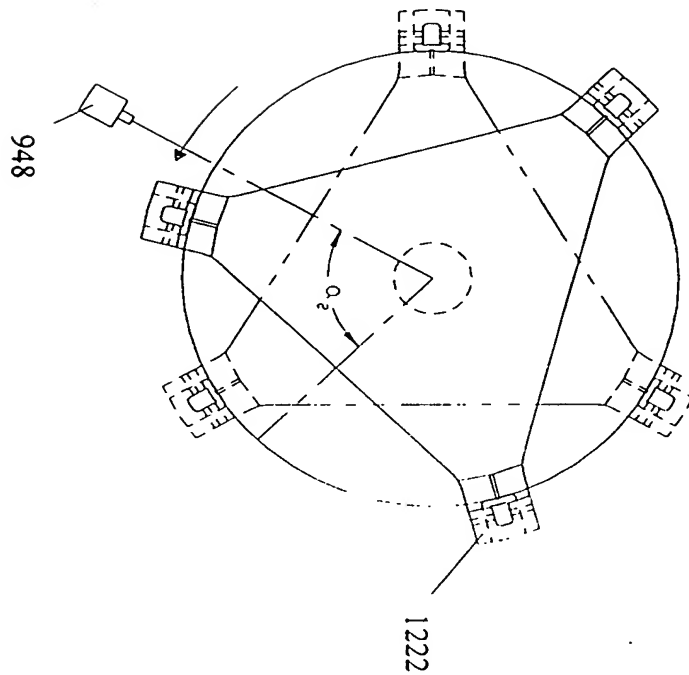
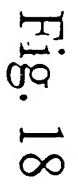


Fig. 17C





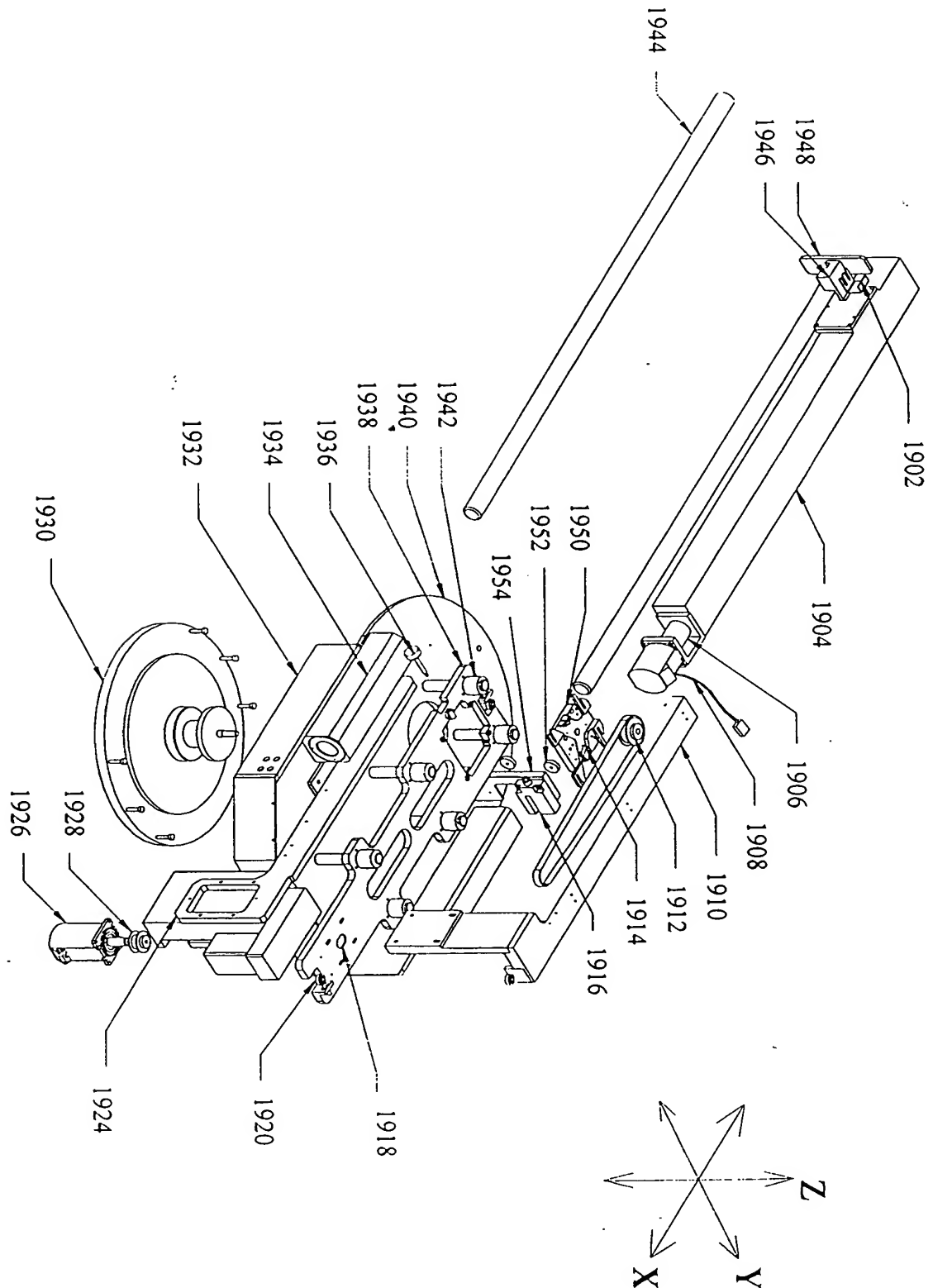
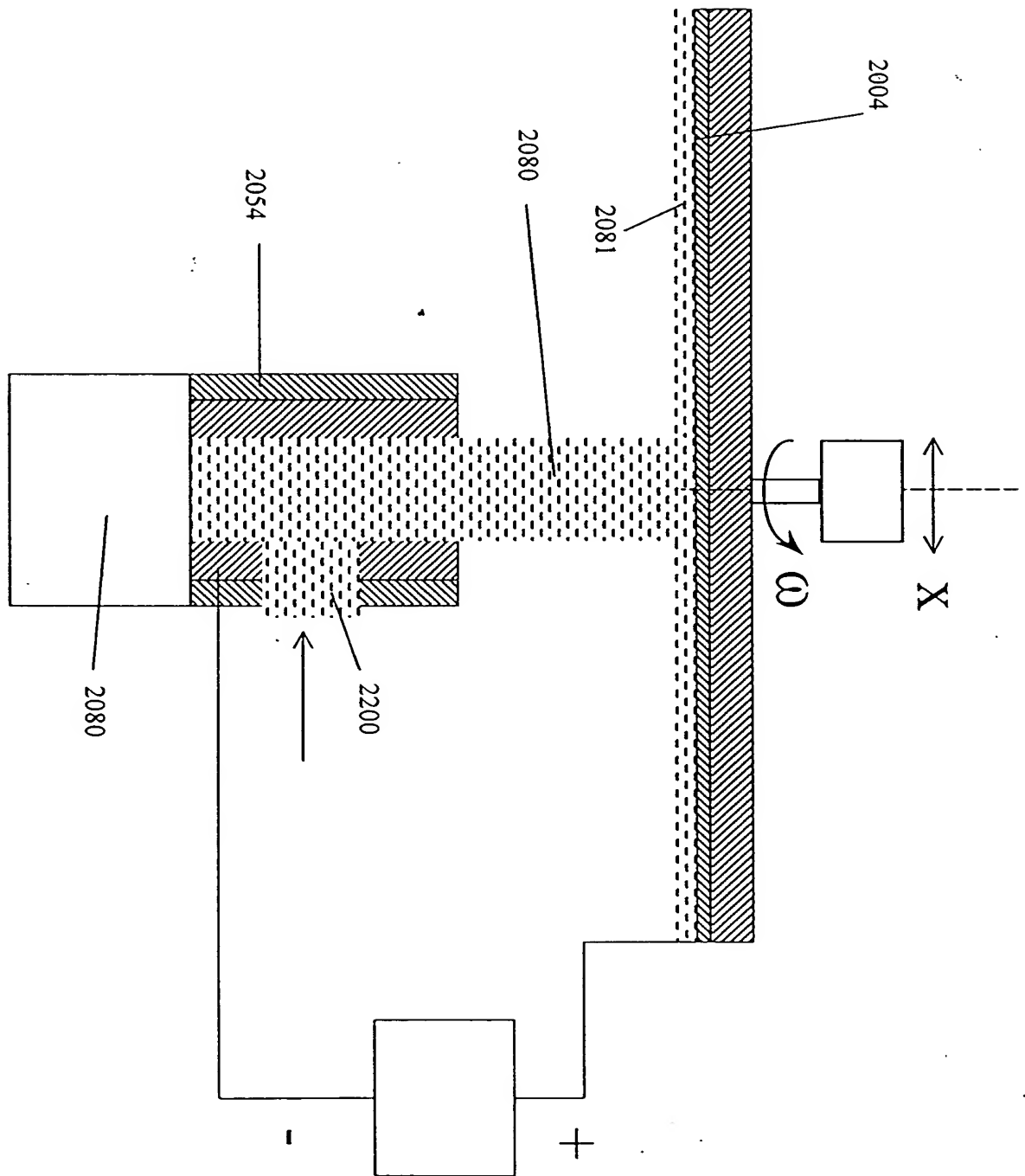


Fig. 19

Fig. 20



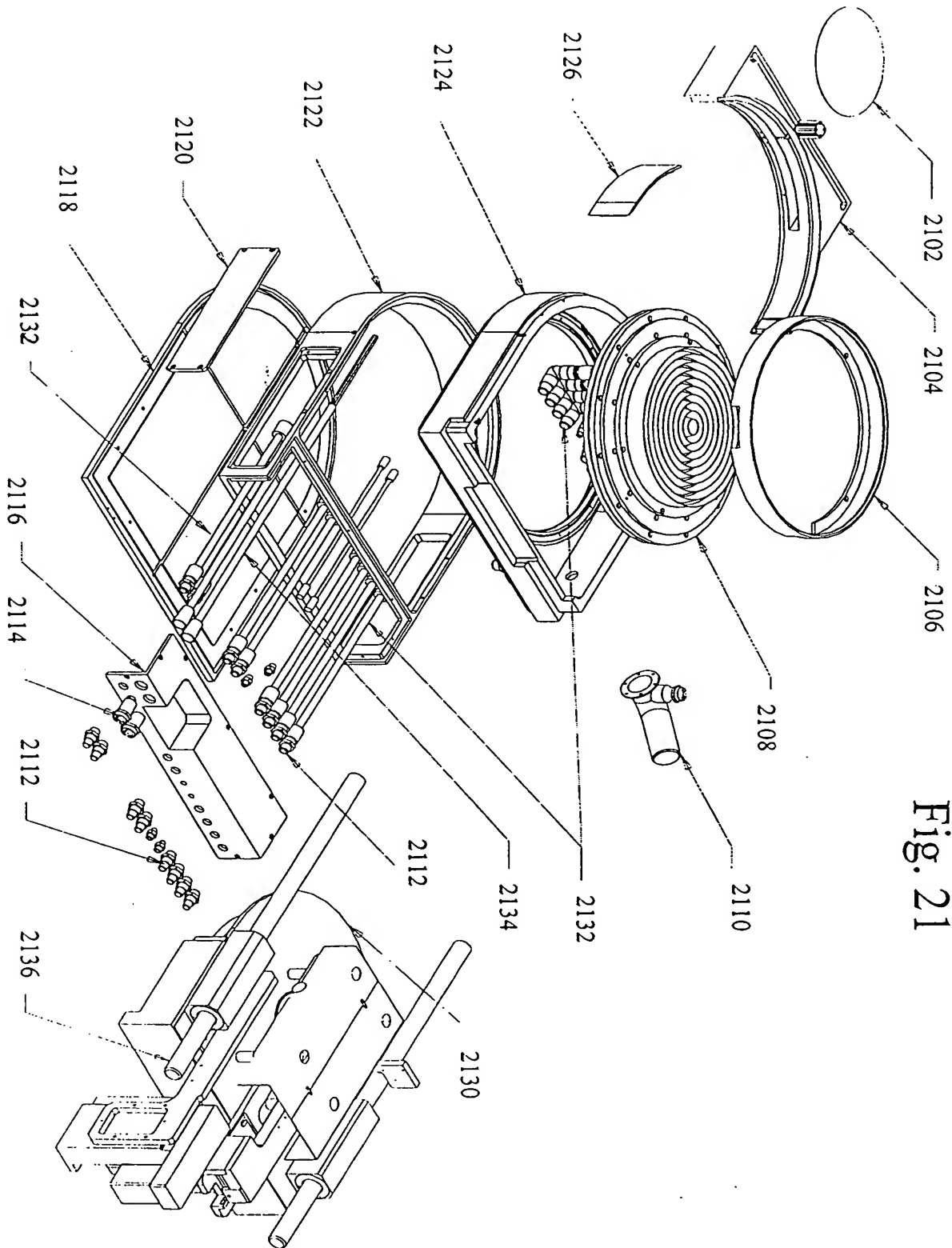


Fig. 22

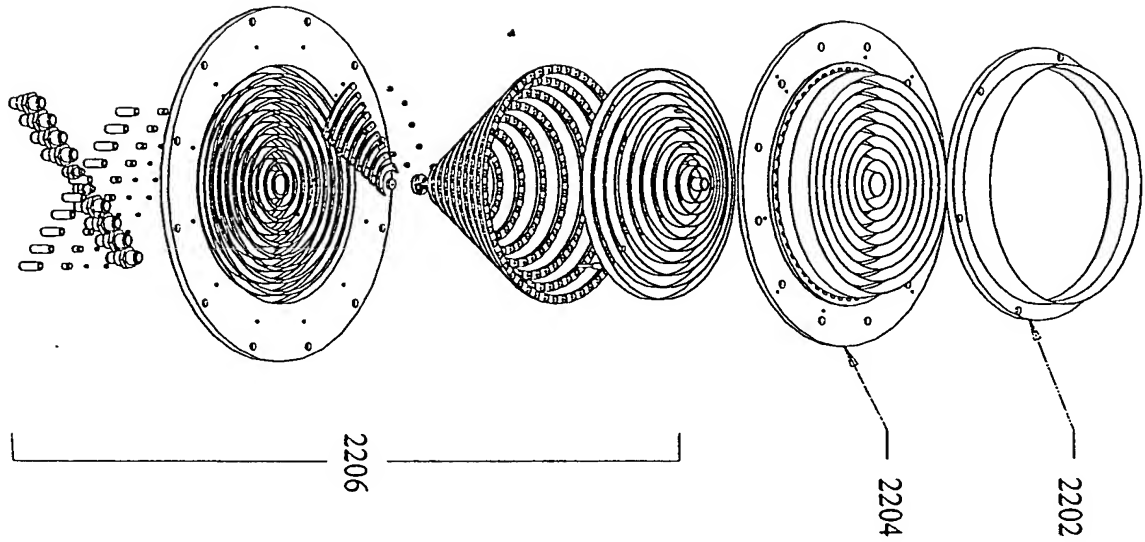


Fig. 23

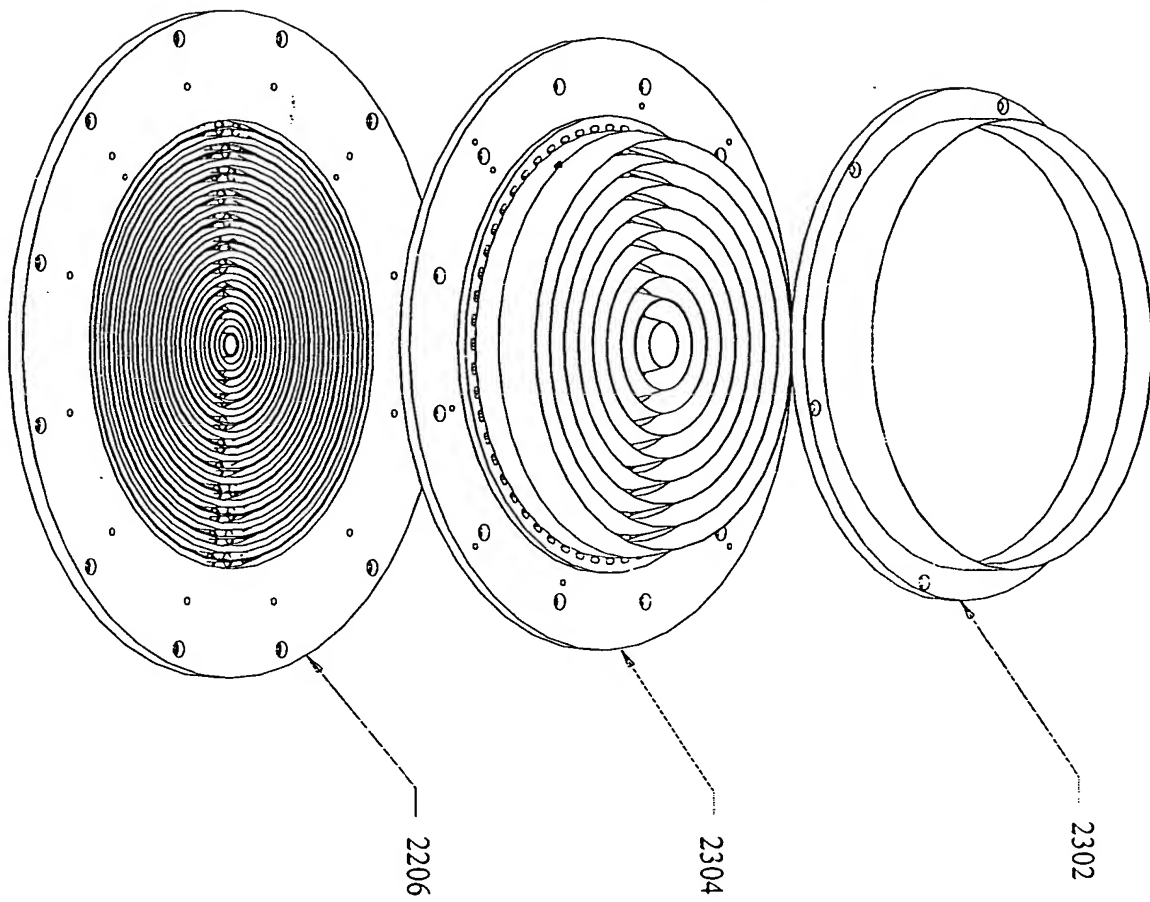
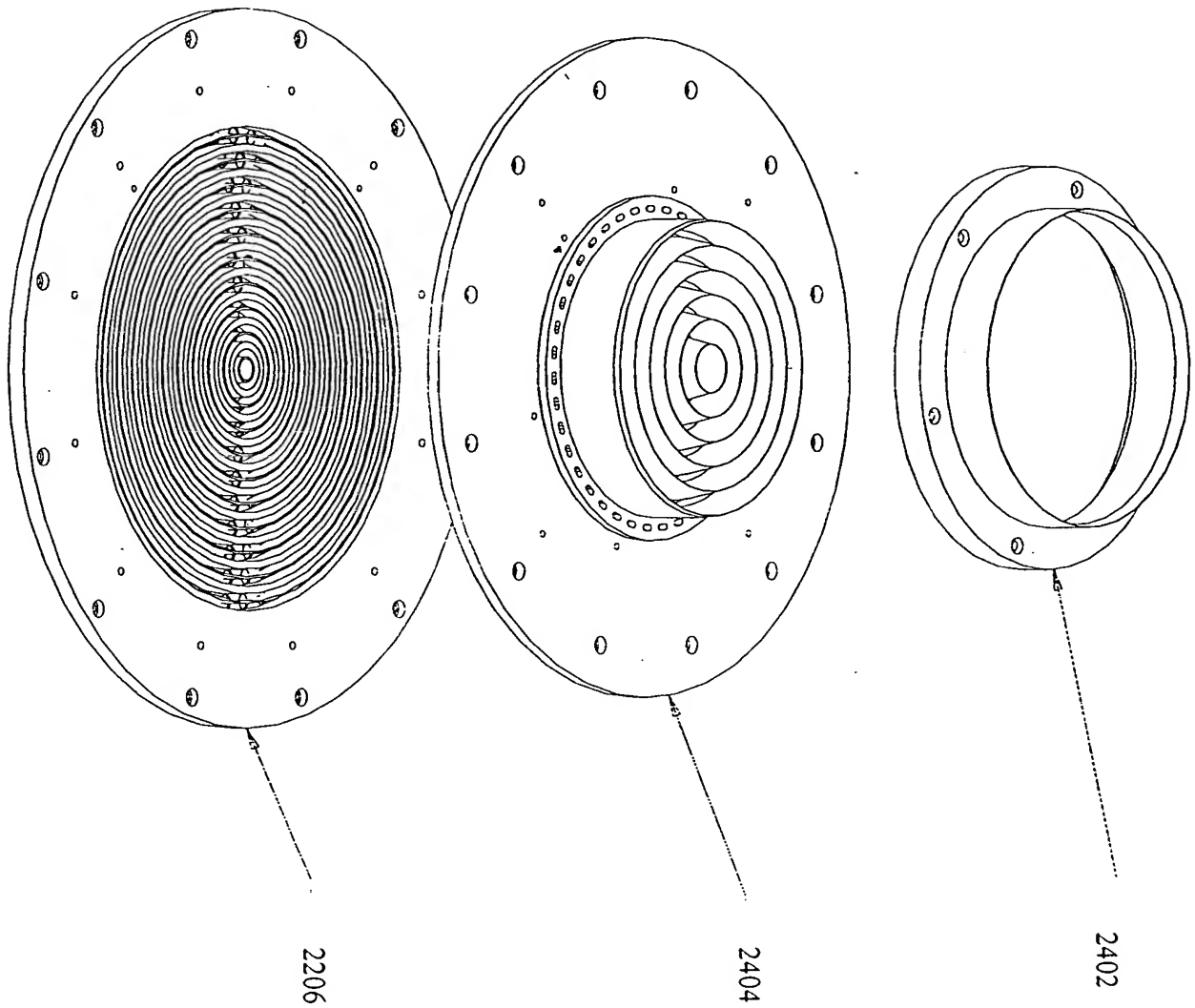


Fig. 24



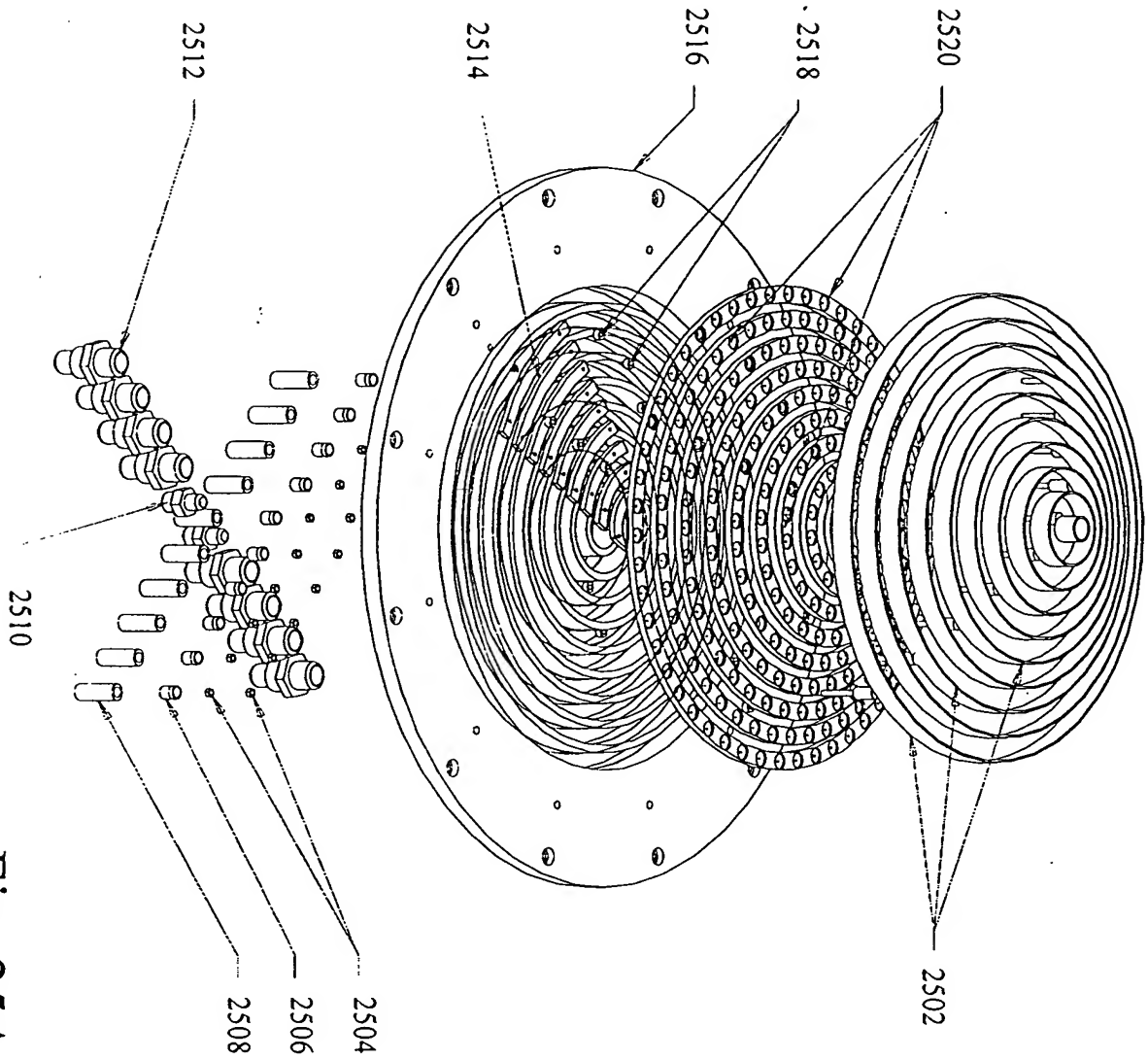


Fig. 25A



Fig. 25B

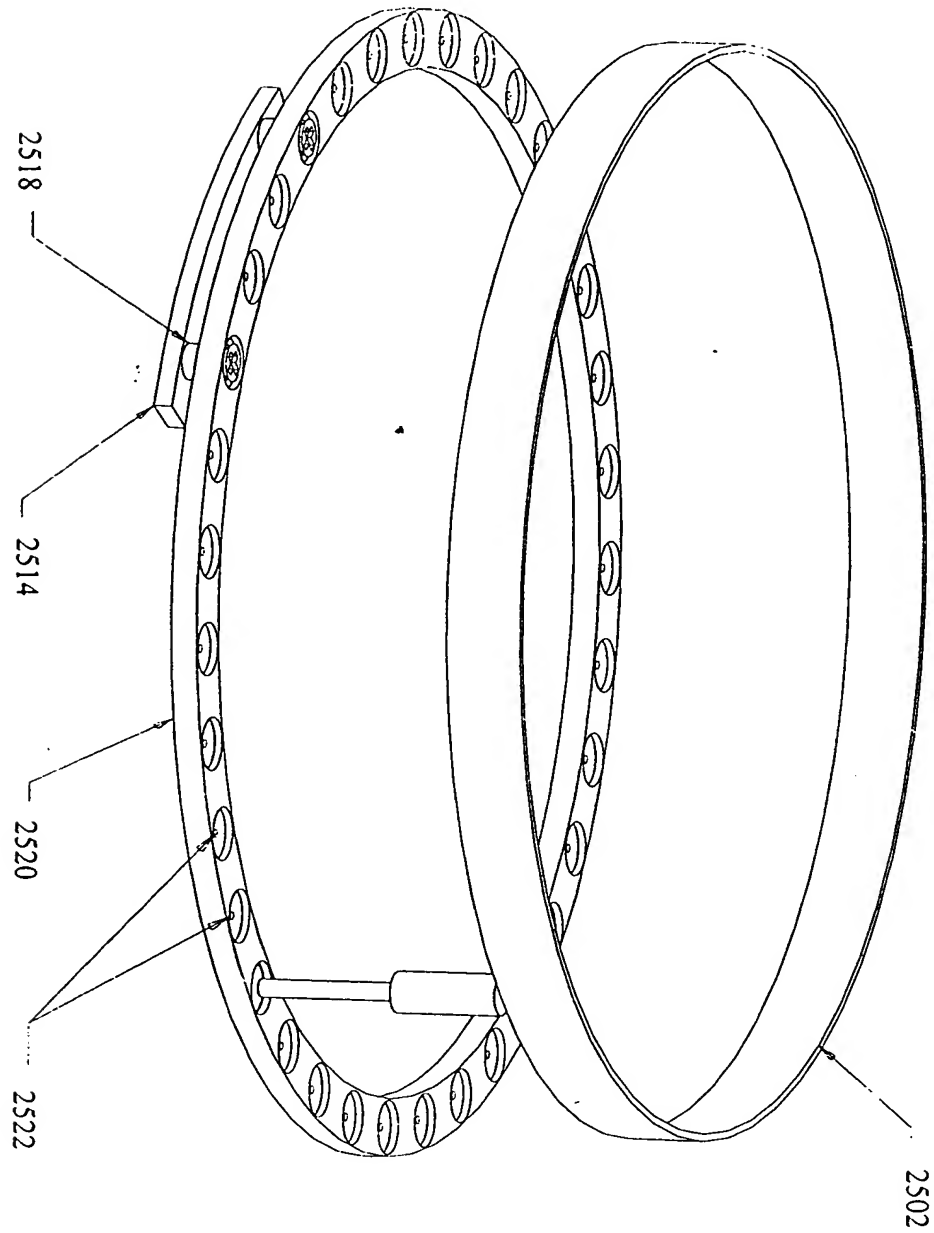


Fig. 25C

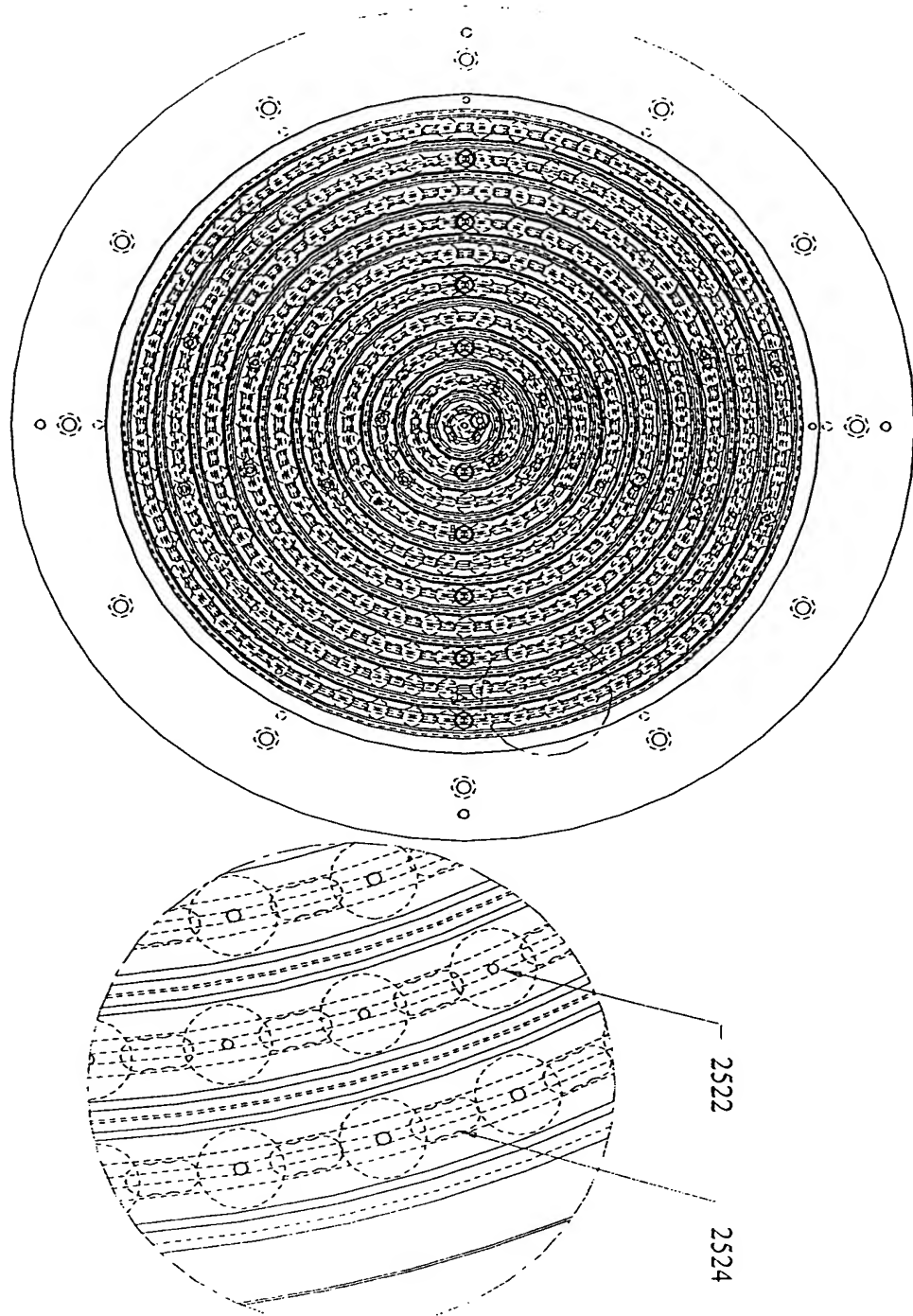
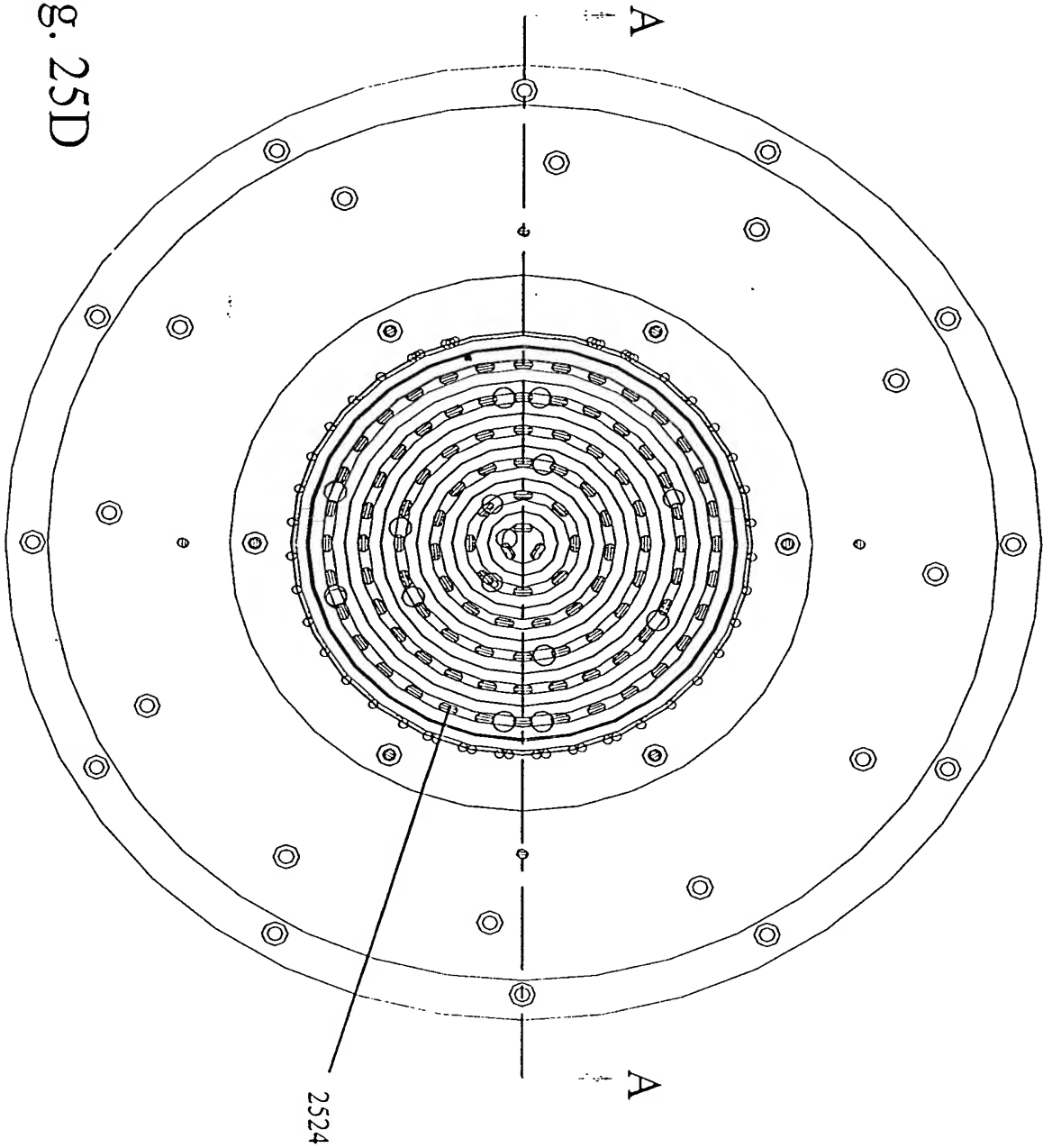


Fig. 25D



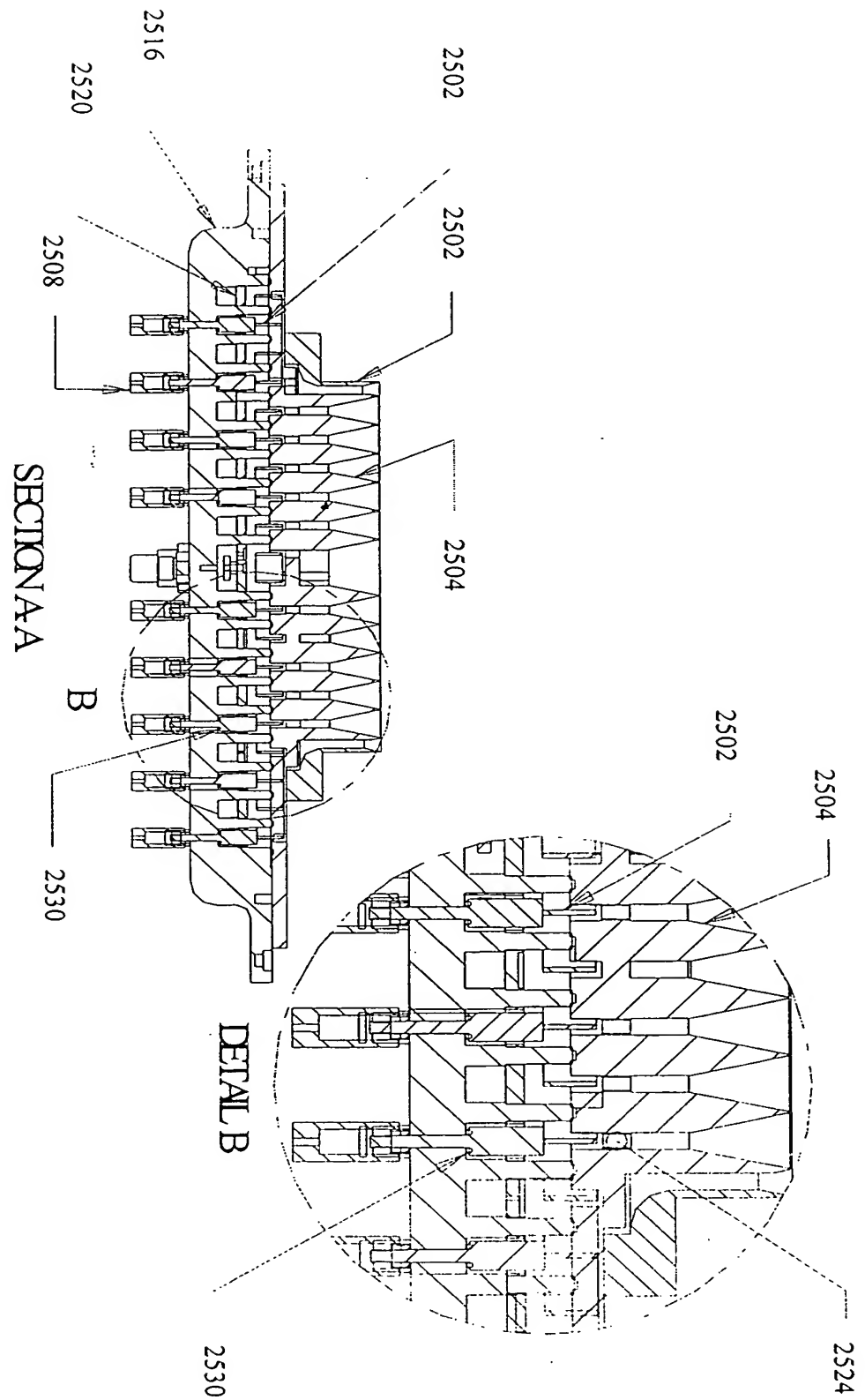


Fig. 25E

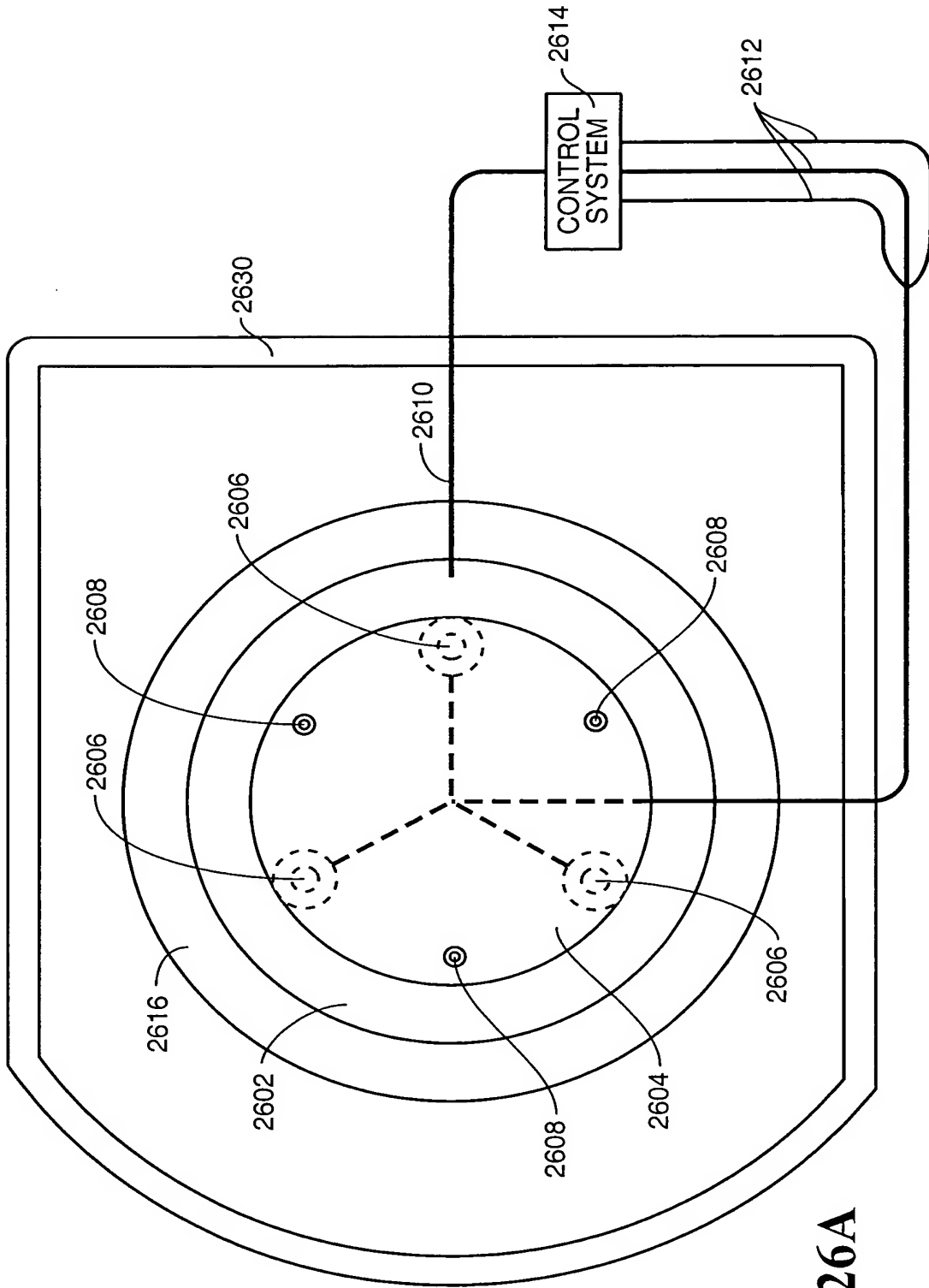


FIG. 26A

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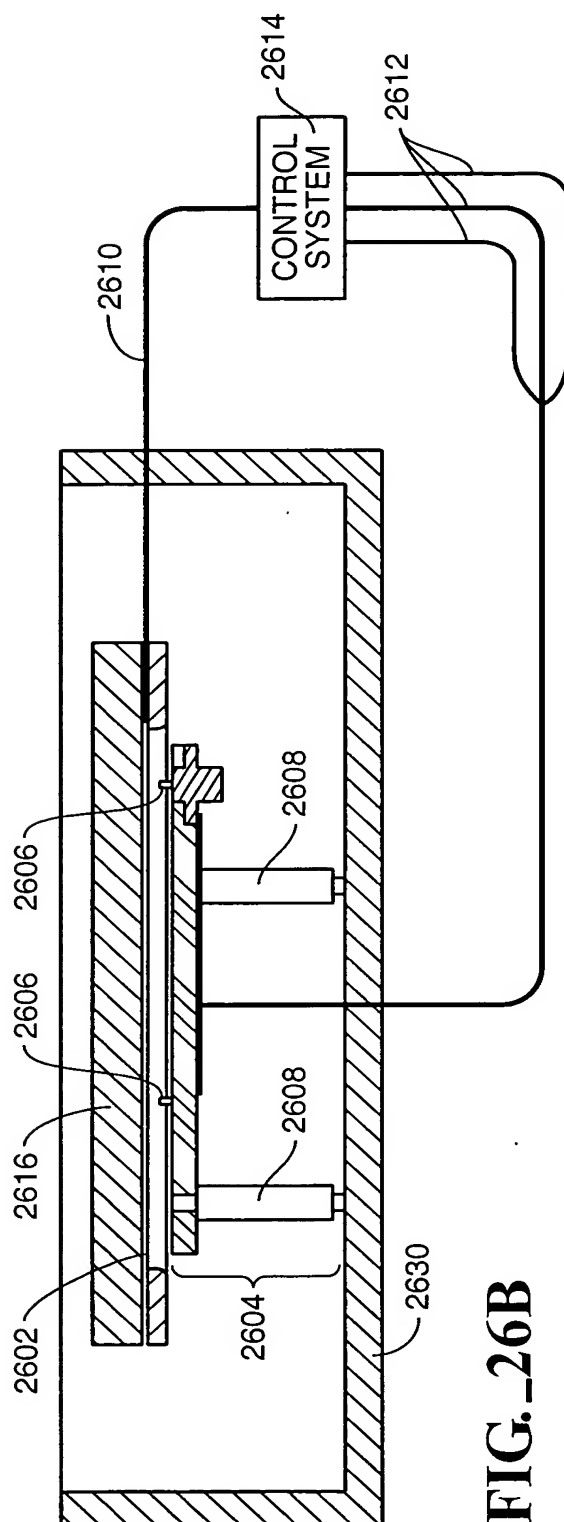
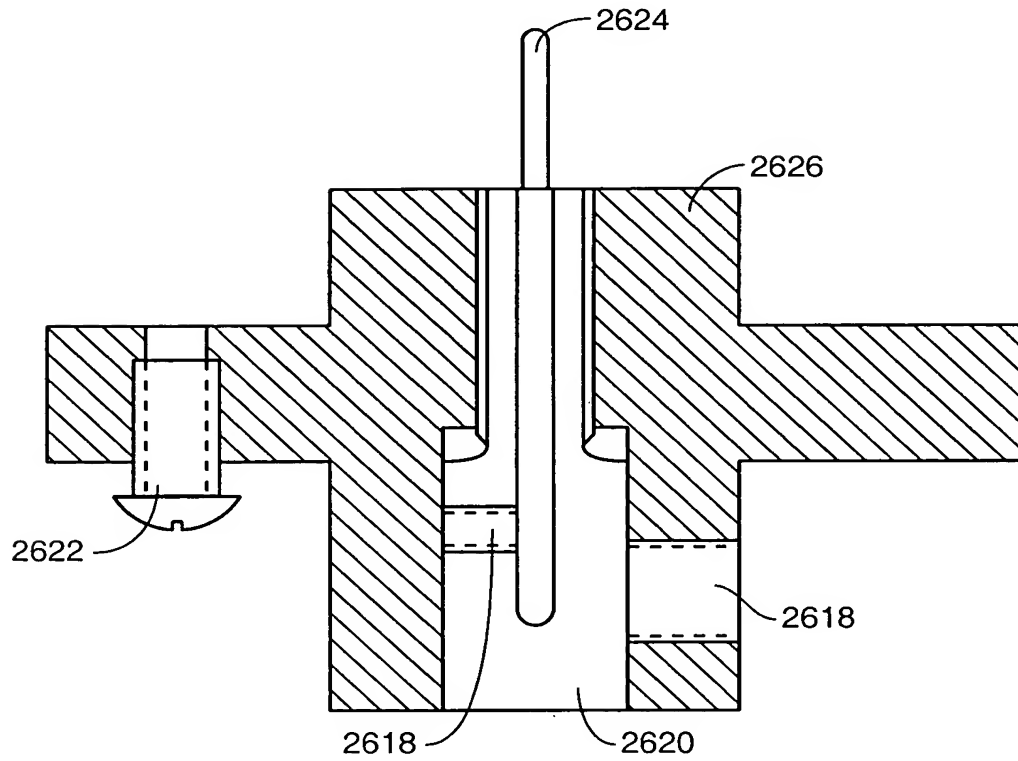


FIG. 26B

**FIG. 26C**

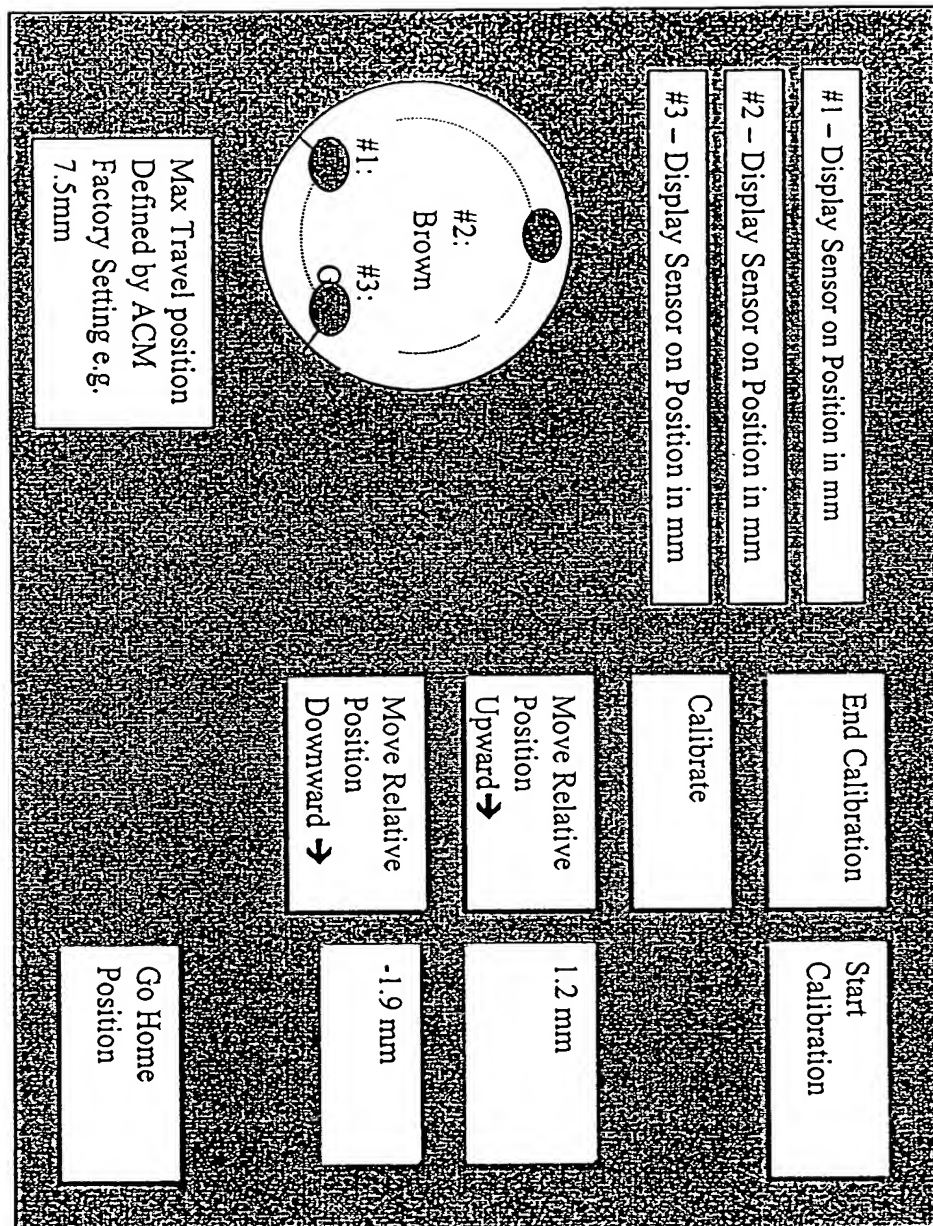


Fig. 27